

## **TDA7572**

## 200W mono bridge PWM amplifier with built-in step-up converter

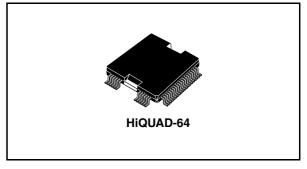
**Preliminary Data** 

#### **Features**

- Input stage and gain compressor
- Over-modulation protection and current limiting
- Modulator
- DAC
- Step-up
- Mode control
- Diagnostics / safety
- Power control



TDA7572 is a highly integrated, highly versatile, semi-custom IC switch mode audio amplifier. It integrates audio signal processing and power amplification tailored for standalone remote bass box applications, while providing versatility for full bandwidth operation in either automotive or consumer audio environments. It's configured as one full bridge channel, using two clocked PWM modulators driving external, complementary FET's.



Broad operating voltage is supported, allowing operation from both 14V and 42V automotive power buses, as well as from split supplies for consumer electronics use.

A current mode control boost converter controller is provided to allow high power operation in a 14V environment. Turn-on and turn-off transients are minimized by soft muting/unmuting and careful control of offsets within the IC.

Digital Audio input is supported by an integrated one channel DAC. Sophisticated diagnostics and protection provide fault reporting via I<sup>2</sup>C and power shutdown for safety related faults.

TDA7572 is packaged in a HiQUAD-64 package.

Table 1. Device summary

| Order code | Package   | Packing |
|------------|-----------|---------|
| TDA7572    | HiQUAD-64 | Tray    |

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TDA7572 Detailed features

### 1 Detailed features

- Input Stage and Gain Compressor
  - Differential, high CMRR, analog input
  - Programmable input attenuation/gain to support up to four drive levels
  - Noiseless Gain compression of up to 16 dB with programmable attack and decay.
  - Compressor controlled by monitoring estimated THD
  - Soft mute / un-mute for pop control
- Over-modulation Protection and Current Limiting
  - Adaptive pulse injection prevents missing pulses due to over modulation which maximizes useful output swing.
  - Programmable current limiting based on FET VDS

#### Modulator

- Optimized for low distortion at low switching frequency (approximation 110KHz)
- Dual Clocked PWM modulators for 3 state switching
- External gain control / internal integrator components
- Controls 4 external FETS with switching optimized for low EMI
- Oscillation frequency selectable by I<sup>2</sup>C
- Anti-pop shunt driver

#### DAC

- 18bit, mono
- I<sup>2</sup>S inputs 38-48KHz, 96KHz, 192 KHz
- Hybrid architecture, area optimized for Bass
- Full bandwidth supported by off loading the interpolator function
- Synchronization with modulator

#### Step-Up

- On board STEP-UP step up converter, synchronized to the modulator frequency
- Drives external NFET switch
- Externally compensated
- Soft start and current limiting

#### Mode Control

- Critical modes controllable by mode pins for bus-less operation
- I<sup>2</sup>C provides additional mode control

#### Diagnostics / Safety

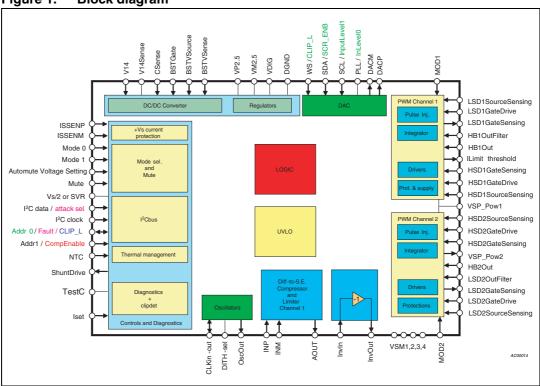
- Offset, short, open, overcurrent, over temperature
- I<sup>2</sup>C used to report errors, and for configuration control
- Faults pin used to report errors in bus-less environment
- Clipping reported at a separate pin
- Abnormal supply current detection disables input power for fail safe operation
- Output current limiting
- Power control
- Latching control of an external PMOS power switch for safety related faults.
- Power is switched off for safety related faults of abnormal supply current, excessive internal or external temperature, or persistent output stage over-current that fails to be controlled by the pulse-by-pulse current limiting method

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# 2 Interface description

I<sup>2</sup>C bus and mode control pins are use to control operation. Default values of all the operating modes are deterministic, some of these values are intrinsic to the IC and some are determined by configurations pins. The configuration pins are read at power-up and copied into registers, which may later be modified using the I<sup>2</sup>C bus, if one is present. This allows varied operation in an environment where NOI<sup>2</sup>C bus is present, while allowing full control and override of pin programmed modes when used with I<sup>2</sup>C.

Figure 1. Block diagram

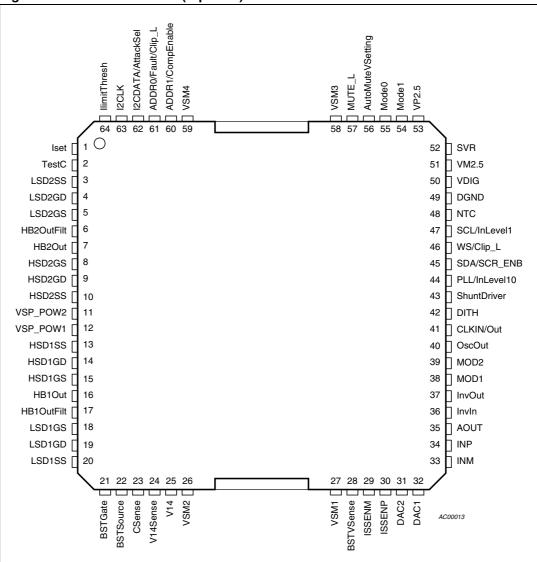


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TDA7572 Pins description

# 3 Pins description

Figure 2. Pins connection (top view)



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Pins description TDA7572

Table 2. Pin list by argument

| Pin #     | Pin name                        | Description  |  |
|-----------|---------------------------------|--|--|
| On/Off C  | ircuitry                        |  |  |
| 11        | VSP_POW2                        | Positive supply power for low power, non gate-drive functions with a separate bonding to power the gate drive of modulator two |  |
| 53        | VP2.5                           | +2.5V analog supply output   |  |
| 51        | VM2.5                           | -2.5 V analog supply output  |  |
| 50        | VDIG                            | 5V logic supply decoupling   |  |
| .com/49   | DGND                            | Digital gnd  |  |
| 52        | SVR                             | Vs/2 analog reference filter capacitor. Reference for input stage.   |  |
| 55        | Mode0                           | Mode control bit0, selects standby/normal/ I <sup>2</sup> C/diagnostic operation   |  |
| 54        | Mode1                           | Mode control bit1, selects standby/normal/ I <sup>2</sup> C/diagnostic operation   |  |
| 57        | MUTE_L                          | Mute input and / or timing cap, assertion level low  |  |
| 56        | AutoMuteVSetting                | Auto-mute Voltage Setting  |  |
| Input/ Ga | in Compressor                   |  |  |
| 34        | INP                             | Non inverting audio input  |  |
| 33        | INM                             | Inverting audio input  |  |
| 35        | 35 AOUT Compressed Audio Output |  |  |
|           |                                 | Input Stage gain selection – see PLL pin in DAC Section 8  |  |
|           |                                 | Compressor attack/decay select – see I <sup>2</sup> C data pin in DAC Section 8  |  |
| Inverter  |                                 |  |  |
| 36        | Invln                           | Inverter input   |  |
| 37        | InvOut                          | Inverter Output  |  |
| Modulato  | or                              |  |  |
| 64        | IlimitThresh                    | Output stage Current Limiting trip voltage set point   |  |
| 32        | LVLSFT                          | Gain program pin for SVR to HVCC level shifting  |  |
| 38        | MOD1                            | Modulator1 Inverting / Summing node  |  |
| 20        | LSD1SS                          | Lowside1 Source Sensing  |  |
| 19        | LSD1GD                          | Lowside1 Gate Drive  |  |
| 18        | LSD1GS                          | Lowside1 Gate sense  |  |
| 17        | HB1OutFilt                      | Half bridge1 post-LC filter – for diagnostics  |  |
| 16        | HB1Out                          | Half-bridge1 output, HSD 1 drain sense, LSD1 Drain Sense   |  |
| 15        | HSD1GS                          | Highside1 Gate sense   |  |
| 14        | HSD1GD                          | Highside1 Gate Drive   |  |
| 13        | HSD1SS                          | Highside1 Source sense   |  |
| 12        | VSP_POW1                        | Positive supply voltage connection for gate drive circuitry  |  |

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TDA7572 Pins description

Table 2. Pin list by argument (continued)

|       | Table 2.          | r in list by arguine           | (Continued)  |
|-------|-------------------|--------------------------------|--|
|       | Pin #             | Pin name                       | Description  |
|       | 39                | MOD2                           | Modulator2 Inverting / Summing node  |
|       | 10                | HSD2SS                         | Highside2 Source sense   |
|       | 9                 | HSD2GD                         | Highside2 Gate Drive   |
|       | 8                 | HSD2GS                         | Highside2 Gate sense   |
|       | 7                 | HB2Out                         | Half-bridge2 output, HSD 1 drain sense, LSD1 Drain Sense   |
|       | 6                 | HB2OutFilt                     | Half bridge2 post-LC filter – for diagnostics  |
| eet4l | .com <sub>5</sub> | LSD2GS                         | Lowside2 Gate sense  |
|       | 4                 | LSD2GD                         | Lowside2 Gate Drive  |
|       | 3                 | LSD2SS                         | Lowside2 Source Sense  |
|       | 27                | VSM1                           | Die tab connection to lowest supply voltage – gnd for single ended supplies, negative supply for split supplies                    |
|       | 26                | VSM2                           | Die tab connection to lowest supply voltage – gnd for single ended supplies, negative supply for split supplies                    |
|       | 58                | VSM3                           | Die tab connection to lowest supply voltage – gnd for single ended supplies, negative supply for split supplies                    |
|       | 59                | VSM4                           | Die tab connection to lowest supply voltage – gnd for single ended supplies, negative supply for split supplies                    |
|       | 43                | ShuntDriver                    | Shunt Driver   |
|       | DC-DC             |                                |  |
|       | 28                | BSTVSense                      | Voltage feedback input for Voltage Booster   |
|       | 22                | BSTSource                      | Boost Converter NFET Source  |
|       | 21                | BSTGate                        | Boost Converter NFET gate drive  |
|       | 23                | CSense                         | Inverting input for Booster Current Sensing and Digital Test Enable (operating when is more then about 3V under the V14 pin level) |
|       | 24                | V14Sense                       | Non-inverting input for Booster Current Sensing  |
|       | 25                | V14                            | Power for Boost converter gate drive and Output LSD's  |
|       | Oscillato         | or                             |  |
|       | 41                | CLKIN/Out                      | Clock input  |
|       | 42                | DITH                           | Dither capacitor   |
|       | 40                | OscOut                         | Oscillator output  |
|       | Diagnos           | tics / Bus                     |  |
|       | 62                | I <sup>2</sup> CDATA/AttackSeI | I <sup>2</sup> C data (I <sup>2</sup> C mode) Compressor aggressiveness selection (non-bus mode)                                   |
|       | 63                | I <sup>2</sup> CLK             | I <sup>2</sup> C Clock   |
|       |                   | <u> </u>                       |  |

Pins description TDA7572

Table 2. Pin list by argument (continued)

| Pin # | Pin name   | Description   |
|-------|--|---|
| 61    | ADDR0/Fault/Clip_L   | I <sup>2</sup> C address set (I <sup>2</sup> C mode) Fault output in non bus mode (non-bus mode) Clipping indicator, assertion level low, (when DAC is enabled) |
| 60    | ADDR1/CompEnable   | I <sup>2</sup> C address set (I <sup>2</sup> C mode)<br>Compressor Enable/disable (non-bus mode)  |
| 48    | NTC  | Connection for NTC thermistor   |
| 2     | TestC  | Test cap used to generate the slow current pulses   |
| 1     | ISet   | Program pin for current level used in Short/Open test   |
| 30    | ISSENP   | Supply non-inverting current sense  |
| 29    | ISSENM   | Supply inverting current sense  |
| DAC   |  |   |
| 46    | WS / Clip_L  | I <sup>2</sup> S Word select / Clipping indicator, assertion level low (non-DAC mode)   |
| 45    | SDA/SCR_ENB  | I <sup>2</sup> C serial data / SCR ENABLE (non DAC mode)  |
| 47    | SCL/ InLevel1 I <sup>2</sup> C serial data bit clock/ Input Level selection bit1 (non-DAC mode |   |
| 44    | PLL/InLevel0 DAC clock PLL filter/ Input Level selection bit 0 (non-DAC mode)                  |   |
| 31    | DAC2   | DAC output voltage p  |
| 32    | DAC1   | DAC output voltage n  |

Table 3. Pin list by pin

|       | 7 1   |   |  |
|-------|---|---|--|
| Pin # | Pin name  | Description   |  |
| 1     | lset  | Program pin for current level used in Short/Open test         |  |
| 2     | TestC   | Test cap used to generate the slow current pulses             |  |
| 3     | LSD2SS  | Lowside2 Source Sense   |  |
| 4     | LSD2GD  | Lowside2 Gate Drive   |  |
| 5     | LSD2GS  | Lowside2 Gate sense   |  |
| 6     | HB2OutFilt Half bridge2 post-LC filter – for diagnostics  |   |  |
| 7     | HB2Out  | 2Out Half-bridge2 output, HSD 1 drain sense, LSD1 Drain Sense |  |
| 8     | HSD2GS  | Highside2 Gate sense  |  |
| 9     | HSD2GD  | 2GD Highside2 Gate Drive                                      |  |
| 10    | HSD2SS Highside2 Source sense   |   |  |
| 11    | Positive supply power for low power, non gate-drive functions with a sep bonding to power the gate drive of modulator two |   |  |
| 12    | VSP_POW1  | Positive supply voltage connection for gate drive circuitry   |  |
| 13    | HSD1SS  | Highside1 Source sense  |  |
| 14    | HSD1GD  | 1GD Highside1 Gate Drive                                      |  |
| 15    | HSD1GS  | Highside1 Gate sense  |  |

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TDA7572 Pins description

Table 3. Pin list by pin (continued)

|                | Table 3. | Pili list by pili (coi | ininaca)   |
|----------------|----------|------------------------|--|
|                | Pin #    | Pin name               | Description  |
|                | 16       | HB1Out                 | Half-bridge1 output, HSD 1 drain sense, LSD1 Drain Sense   |
|                | 17       | HB1OutFilt             | Half bridge1 post-LC filter – for diagnostics  |
|                | 18       | LSD1GS                 | Lowside1 Gate sense  |
|                | 19       | LSD1GD                 | Lowside1 Gate Drive  |
|                | 20       | LSD1SS                 | Lowside1 Source Sensing  |
|                | 21       | BSTGate                | Boost Converter NFET gate drive  |
| ww.DataSheet4U | .com22   | BSTSource              | Boost Converter NFET Source  |
|                | 23       | CSense                 | Inverting input for Booster Current Sensing and Digital Test Enable (operating when is more then about 3V under the V14 pin level) |
| ļ              | 24       | V14Sense               | Non-inverting input for Booster Current Sensing  |
|                | 25       | V14                    | Power for Boost converter gate drive and Output LSD's  |
|                | 26       | VSM2                   | Die tab connection to lowest supply voltage – gnd for single ended supplies, negative supply for split supplies                    |
|                | 27       | VSM1                   | Die tab connection to lowest supply voltage – gnd for single ended supplies, negative supply for split supplies                    |
| ļ              | 28       | BSTVSense              | Voltage feedback input for Voltage Booster   |
| ļ              | 29       | ISSENM                 | Supply inverting current sense   |
| ļ              | 30       | ISSENP                 | Supply non-inverting current sense   |
| ļ              | 31       | DAC2                   | Half VCC (VSP- VSM)/2 Used for output stage reference.   |
| ļ              | 32       | DAC1                   | Gain program pin for SVR to HVCC level shifting  |
|                | 33       | INM                    | Inverting audio input  |
|                | 34       | INP                    | Non inverting audio input  |
|                | 35       | AOUT                   | Compressed Audio Output  |
|                | 36       | Invln                  | Inverter input   |
|                | 37       | InvOut                 | Inverter Output  |
|                | 38       | MOD1                   | Modulator1 Inverting / Summing node  |
|                | 39       | MOD2                   | Modulator2 Inverting / Summing node  |
|                | 40       | OscOut                 | Oscillator output  |
|                | 41       | CLKIN/Out              | Clock input  |
|                | 42       | DITH                   | Dither capacitor   |
|                | 43       | ShuntDriver            | Shunt Driver   |
|                | 44       | PLL/InLevel0           | DAC clock PLL filter/ Input Level selection bit 0 (non-DAC mode)   |
|                | 45       | SDA/SCR_ENB            | I <sup>2</sup> C serial data / SCR ENABLE (non DAC mode)   |
|                | 46       | WS / Clip_L            | I <sup>2</sup> S Word select / Clipping indicator, assertion level low (non-DAC mode)  |
|                | 47       | SCL/ InLevel1          | I <sup>2</sup> C serial data bit clock/ Input Level selection bit1 (non-DAC mode)  |
|                | 48       | NTC                    | Connection for NTC thermistor  |

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Table 3. Pin list by pin (continued)

| Pin #  | Pin name                       | Description   |
|--------|--------------------------------|---|
| 49     | DGND                           | GND logic supply decoupling   |
| 50     | VDIG                           | 5V logic supply decoupling  |
| 51     | VM2.5                          | -2.5 V analog supply output   |
| 52     | SVR                            | Vs/2 analog reference filter capacitor. Reference for input stage.  |
| 53     | VP2.5                          | +2.5 V analog supply output   |
| 54     | Mode1                          | Mode control bit1, selects standby/normal/l <sup>2</sup> C/diagnostic operation   |
| .com55 | Mode0                          | Mode control bit0, selects standby/normal/ I <sup>2</sup> C/diagnostic operation  |
| 56     | AutoMuteVSetting               | Auto-mute Voltage Setting   |
| 57     | MUTE_L                         | Mute input and / or timing cap, assertion level low   |
| 58     | VSM3                           | Die tab connection to lowest supply voltage – gnd for single ended supplies, negative supply for split supplies   |
| 59     | VSM4                           | Die tab connection to lowest supply voltage – gnd for single ended supplies, negative supply for split supplies   |
| 60     | ADDR1/CompEnable               | I <sup>2</sup> C address set (I <sup>2</sup> C mode) Compressor Enable/disable (non-bus mode)   |
| 61     | ADDR0/Fault/Clip_L             | I <sup>2</sup> C address set (I <sup>2</sup> C mode) Fault output in non bus mode (non-bus mode) Clipping indicator, assertion level low, (when DAC is enabled) |
| 62     | I <sup>2</sup> CDATA/AttackSel | I <sup>2</sup> C data (I <sup>2</sup> C mode)<br>Compressor aggressiveness selection (non-bus mode)   |
| 63     | I <sup>2</sup> CLK             | I <sup>2</sup> C Clock  |
| 64     | IlimitThresh                   | Output stage Current Limiting trip voltage setpoint   |

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# 4 Electrical specifications

### 4.1 Absolute maximum ratings

Table 4. Absolute maximum ratings

| Symbol                 | Parameters           | Test Conditions                               | Min.                 | Max.                | Units |
|------------------------|----------------------|---|----------------------|---------------------|-------|
| $V_{SP}$               | Supply voltage       |   | V <sub>SM</sub> -0.6 | V <sub>SM</sub> +58 | V     |
| V <sub>peak</sub>      | Peak supply voltage  | $(V_{S+} - V_{S-})$ time $\leq 50$ ms         |                      | 68                  | ٧     |
| ··corv <sub>DATA</sub> | Data pin voltage     | w.r.t Dgnd                                    | V <sub>S</sub> _0.6  | 6V                  | ٧     |
| T <sub>J</sub>         | Junction temperature |   | -40                  | 150                 | С     |
| T <sub>Stg</sub>       | Storage temperature  |   | -55                  | 150                 | С     |
| P <sub>DMAX</sub>      | Power Dissipation    | Any operating condition For thermal budgeting |                      | 2.5                 | W     |

### 4.2 Thermal data

Table 5. Thermal data

| Symbol                 | Parameters                          | Value | Units |
|------------------------|-------------------------------------|-------|-------|
| R <sub>Th j-case</sub> | Thermal resistance junction to case | 3     | °C/W  |

### 4.3 Electrical characteristics

Unless otherwise specified, all ratings below are for -40°C <  $T_J$  < 125°C,  $V_{SP}$  = 42V,  $V_{SM}$  = 0V and the application circuit of *Figure 12*. Operation of the IC above this junction temperature will continue without audible artifacts until thermal shutdown, but these parameters are not guaranteed to be within the specifications below.  $F_{PWM}$ =110KHz, Booster not enabled.

### 4.3.1 Operating voltage and current

Table 6. Operating voltage and current

|                   | 1  |   |      |      |      |       |
|-------------------|--|---|------|------|------|-------|
| Symbol            | Parameters                               | Test conditions   | Min. | Тур. | Max. | Units |
| V <sub>SP42</sub> | Operating voltage 42V automotive range   | Normal operation without audible defects required Single ended supply 42V configuration, V <sub>SM</sub> =0 | 30   | 42   | 58   | V     |
| V <sub>SP14</sub> | Operating voltage 14.4V automotive range | Normal operation without audible defects required Single ended supply 14V configuration, V <sub>SM</sub> =0 | 9    | 14.4 |      | v     |

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Table 6. Operating voltage and current (continued)

| Symbol             | Parameters   | Test condit   | ions        | Min. | Тур. | Max.                                   | Units |
|--------------------|--|---|-------------|------|------|--|-------|
| V <sub>SPLIT</sub> | Operating voltage V <sub>SP</sub> - V <sub>SM</sub> split supply rails | Normal operation req<br>Split supply application<br>configuration, V <sub>SM</sub> <v<sub>SP&gt;V<sub>SVR</sub>+4</v<sub> | on          | 8    | 48   | 58                                     | V     |
| I <sub>stdby</sub> | Stand-by current   | IC in standby, Mode0.   | , and Mode1 |      |      | 50 at<br>T = 25°C<br>10 at<br>T = 85°C | μΑ    |
| U.com              |  | Outputs tristated   | V14         |      | 13   | 20                                     |       |
| Itristate          | Tristate current   | Booster not running,<br>F <sub>pwm</sub> = nominal  | VSP         |      | 15   | 25                                     | mA    |
| 1                  | Mute mode current  | MUTE asserted,  | V14         |      | 10   |  | mA    |
| MUTE               | iwate mode carrent   | INIOTE asserted,  | VSP         |      | 20   |  | IIIA  |

4.3.2 Under voltage lockout

Table 7. Under voltage lockout

| Symbol             | Parameters  | Test conditions   | Min. | Тур.         | Max. | Units |
|--------------------|---|---|------|--------------|------|-------|
| V <sub>LimAM</sub> | AutomuteVSetting pin voltage limit                                  | Voltage limit respect to the SVR pin<br>Allowed voltage range on Automute<br>pin                                | 0.5  |              | 2.1  | V     |
| VSP UVLO           |   |   |      |              |      |       |
| V <sub>AM</sub>    | Auto-mute supply voltage VSP  | Mute is forced if VSP-VSVR or VSVR-VSM is less than this value VautomuteVSetting-V <sub>SVR</sub> =VVSVR        | -15% | VVSVR*       | +15% | V     |
| VPO-               | Auto-tristate supply voltage VSP negative slope                     | The IC is set in tristate if VSP-VSM is less than this value<br>Vautomute VSetting-V <sub>SVR</sub> =VVSVR      | -15% | VVSVR<br>*12 | +15% | V     |
| VPO+               | Auto-tristate supply voltage VSP positive slope                     | The IC is set out from tristate if VSP-VSM is higher than this value Vautomute VSetting-V <sub>SVR</sub> =VVSVR | -15% | VVSVR<br>*13 | +15% | V     |
| V <sub>U</sub>     | Auto-tristate supply<br>voltage VSP<br>Relative maximum value       | The IC is set in tristate if VSP-VSM is more than this value Vautomute VSetting-V <sub>SVR</sub> =VVSVR         | -15% | VVSVR*<br>48 | +15% | V     |
| V <sub>UC</sub>    | Auto-tristate supply<br>voltage<br>VSP<br>Absolute maximum<br>value | The IC is set in tristate if VSP-VSM is higher than this value  | 60   | 63           | 66   | V     |

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Table 7. Under voltage lockout (continued)

| Symbol       | Parameters                                      | Test conditions   | Min.               | Тур.            | Max.                | Units |
|--------------|---|---|--------------------|-----------------|---------------------|-------|
| V14 – UVLO   |   |   | •                  |                 |                     |       |
| V14-         | Auto-tristate supply voltage V14 negative slope | The IC is kept in tristate if 14V - VSM become lower than this value  | 5.5                |                 | 7                   | V     |
| V14+         | Auto-tristate supply voltage V14 positive slope | The IC is goes out from tristate if 14V-VSM become higher than this value   | 6.5                |                 | 8                   | V     |
| .com<br>V14h | Auto-tristate 14V voltage hysteresis            | Comparator hysteresis for auto-<br>tristate threshold   | 0.8                |                 |                     | V     |
| V14su        | Step-up tristate                                | The step-up is in tristate when voltage lower than this threshold   | 5                  |                 | 8                   | ٧     |
| V14mute-     | Auto-mute supply voltage V14 negative slope     | The IC goes in mute if 14V-VSM become lower than this value   | V14-<br>+<br>0.7V  |                 | V14-<br>+<br>1.2V   | V     |
| V14mute+     | Auto-mute supply voltage V14 positive slope     | The IC goes in play if 14V-VSM become higher than this value  | V14V+<br>+<br>40mV |                 | V14V+<br>+<br>170mV |       |
| SVR – UVLC   | )   |   |                    |                 |                     |       |
| Vsvr-        | Auto-tristate SVR voltage <b>negative slope</b> | The IC is kept in tristate if VSvr - VSM become less than this value  Vautomute VSetting-V <sub>SVR</sub> =VVSVR        | -15%               | 5<br>x<br>VVSVR | +15%                | V     |
| Vsvr+        | Auto-tristate SVR voltage <b>positive slope</b> | The IC is goes out from tristate if Vvr - VSM become higher than this value  Vautomute VSetting-V <sub>SVR</sub> =VVSVR | -15%               | 6<br>x<br>VVSVR | +15%                | V     |
| VPOH         | Auto-tristate SVR<br>Voltage<br>hysteresis      | Comparator hysteresis for auto-<br>tristate threshold<br>Vautomute VSetting-V <sub>SVR</sub> =VVSVR                     | 0.40<br>X<br>VVSVR |                 | 1.2V<br>X<br>VVSVR  | V     |

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## 4.3.3 Input stage

Table 8. Input stage

| Symbol                 | Parameters  | Test conditions   | Min.  | Тур.  | Max.  | Units            |
|------------------------|---|---|-------|-------|-------|------------------|
| Input diff.            | amp./ gain attenuator   |   | L     |       | ı     |                  |
| D                      |   | INLEVEL1=0, INLEVEL0=0  | -30%  | 20    | +30%  |                  |
| R <sub>IN,</sub><br>No |   | INLEVEL1=0, INLEVEL0=1  | -30%  | 12    | +30%  |                  |
| compress               |   | INLEVEL1=1, INLEVEL0=0  | -30%  | 22    | +30%  |                  |
| ion<br>l.com           | land the salatanaa  | INLEVEL1=1, INLEVEL0=1  | -30%  | 12    | +30%  | KO.              |
|                        | Input resistance  | INLEVEL1=0, INLEVEL0=0  | -30%  | 15.6  | +30%  | ΚΩ               |
| R <sub>IN</sub> max    |   | INLEVEL1=0, INLEVEL0=1  | -30%  | 12    | +30%  |                  |
| ion                    |   | INLEVEL1=1, INLEVEL0=0  | -30%  | 16    | +30%  |                  |
|                        |   | INLEVEL1=1, INLEVEL0=1  | -30%  | 12    | +30%  |                  |
|                        |   | INLEVEL1=0, INLEVEL0=0  | 2     |       |       | V <sub>RMS</sub> |
|                        | Input clipping level  | INLEVEL1=0, INLEVEL0=1  | 7     |       |       | $V_{RMS}$        |
| V <sub>InMax</sub>     | Voltage level of the input that trespassed cause clipping in the preamplifier | INLEVEL1=1, INLEVEL0=0  | 2.6   |       |       | $V_{RMS}$        |
| ▼ InMax                |   | INLEVEL1=1, INLEVEL0=1  | 9.5   |       |       | V <sub>RMS</sub> |
|                        |   | INLEVEL1=1,INLEVEL0=1 Not tested in production  | -10   |       | +10   |                  |
| A <sub>IN_0</sub>      |   | (V <sub>AOUT</sub> -V <sub>SVR</sub> ) / (VInP-VinM)<br>INLEVEL1=0, INLEVEL0=0,<br>no compression | -4    | -3    | -2    | dB               |
| A <sub>IN_2</sub>      |   | (V <sub>AOUT</sub> V <sub>SVR</sub> ) / (VInP-VinM)<br>INLEVEL1=0, INLEVEL0=1,<br>no compression  | -15   | -14   | -13   | dB               |
| A <sub>IN_1</sub>      | Input stage gain  | (V <sub>AOUT</sub> V <sub>SVR</sub> ) / (VInP-VinM)<br>INLEVEL1=1, INLEVEL0=0<br>no compression   | -6.3  | -5.3  | -4.3  | dB               |
| A <sub>IN_3</sub>      |   | (V <sub>AOUT</sub> V <sub>SVR</sub> ) / (VInP-VinM)<br>INLEVEL1=1, INLEVEL0=1,<br>no compression  | -17.6 | -16.6 | -15.6 | dB               |
| V <sub>outH</sub>      | AOUT output voltage swing   | With respect to SVR, 10K loading to a buffered version of SVR                                     | 2     |       |       | V                |
| V <sub>outL</sub>      | AOUT output swing   | With respect to SVR, 10K loading to a buffered version of SVR                                     |       |       | -2    | V                |
| AOUT <sub>THD</sub>    | THD   | Vin=1Vrms, f=20-20KHz,<br>INLEVEL1=0, INLEVEL0=0,<br>no compression                               |       | 0.01  | 0.05  | %                |

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Table 8. Input stage

| Symbol              | Parameters                            | Test conditions   | Min. | Тур. | Max. | Units             |
|---------------------|---------------------------------------|---|------|------|------|-------------------|
|                     | Output slew rate                      | Vin=1KHz square wave, 2Vpp,<br>INLEVEL1=0, INLEVEL0=0,<br>no compression<br>Time to transition from 10% to 90%                    |      |      | 8    | μS                |
|                     |                                       | Duty cycle of the Clipping signal   |      | TBD  |      | %                 |
|                     | AOUT clip detector                    | when there is 5% distortion at the output of AOUT, f=1KHz, R <sub>L</sub> =10kOhm   | 15   |      | 25   |                   |
| f <sub>-3dB</sub>   | Frequency response                    | Vin=1Vrms,<br>INLEVEL1=0, INLEVEL0=0  | 20   |      |      | KHz               |
| CMRR                | Common Mode Rejection<br>Ratio        | V <sub>CM</sub> =1V <sub>RMS</sub> @1KHz<br>CMRR= A <sub>VDIFF</sub> /A <sub>VCM</sub><br>INLEVEL1=0, INLEVEL0=0<br>No compressor | 47   |      |      | dB                |
| CG                  | Common gain                           | V <sub>CM</sub> =1V <sub>RMS</sub> @1KHz<br>INLEVEL1=0, INLEVEL0=0<br>No compressor   | 51   |      |      | dB                |
| CG                  | Common gain                           | V <sub>CM</sub> =1V <sub>RMS</sub> @1KHz<br>INLEVEL1=1, INLEVEL0=0<br>No compressor   | 51   |      |      | dB                |
| CG                  | Common gain                           | V <sub>CM</sub> =1V <sub>RMS</sub> @1KHz<br>INLEVEL1=0, INLEVEL0=1<br>No compressor   | 51   |      |      | dB                |
| CG                  | Common gain                           | V <sub>CM</sub> =1V <sub>RMS</sub> @1KHz<br>INLEVEL1=1, INLEVEL0=1<br>No compressor   | 51   |      |      | dB                |
| PSRR                | Power Supply Rejection,<br>Vsp supply | freq<10KHz  | 60   | 80   |      | dB                |
| V <sub>offset</sub> | Output offset                         | V <sub>Offset</sub> with respect to SVR<br>Rin=100 ohms, Mute state   | -4   | 0    | +4   | mV                |
| Eno                 | Noise                                 | Noise at output of this stage<br>f = 20-20KHz, R <sub>input</sub> = 100ohms<br>A weighting  |      | 7    | 10   | μV <sub>RMS</sub> |
| Gain com            | pressor                               |   |      |      |      | _                 |
|                     |                                       | INLEVEL1=0, INLEVEL0=0  | -21  | -19  | -17  |                   |
|                     | Maximum attenuation                   | INLEVEL1=0, INLEVEL0=1  | -30  | -28  | -26  | 40                |
|                     | waxiiiuiii allenualion                | INLEVEL1=1, INLEVEL0=0  | -25  | -23  | -21  | dB                |
|                     |                                       | INLEVEL1=1, INLEVEL0=1  | -34  | -32  | -30  |                   |

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Table 8. Input stage

| Symbol | Parameters   | Test conditions  | Min.             | Тур. | Max.                    | Units |
|--------|--|--|------------------|------|-------------------------|-------|
|        |  | INLEVEL1=0, INLEVEL0=0   | 0.5-0.25         | 0.5  | 0.5+<br>0.25            |       |
|        | Attanuation standard   | INLEVEL1=0, INLEVEL0=1   | 0.44-<br>0.25    | 0.44 | 0.44+<br>0.25           | ٩D    |
|        | Attenuation step size  | INLEVEL1=1, INLEVEL0=0   | 0.55-<br>0.25    | 0.55 | 0.55+<br>0.25           | dB    |
| l.com  |  | INLEVEL1=1, INLEVEL0=1   | 0.48-<br>0.25    | 0.48 | 0.48+<br>0.25           |       |
|        | Gain Change ZC<br>comparator offset<br>(in the diff. – S.E. block)<br>offset | Observed at AOUT pin ZC crossing must be detected within 50mV of the actual zero crossing, | -80              |      | 80                      | mV    |
|        | Gain Change ZC comparator offset (in the diff. – S.E. block) offset          | Observed at InvOut pin ZC crossing must be detected  | -220             |      | +220                    | mV    |
| Mute   |  |  |                  |      |                         |       |
|        | Mute attenuation   | Mute pin voltage = Dgnd<br>Vin=1Vrms   | 90               |      |                         | dB    |
|        | Charge current   | Mute Pin Voltage(57) = 1.5V  | -30%             | 100  | +30%                    | μA    |
|        | Discharge current  | Mute Pin Voltage(57) = 1.5V  | -30%             | 100  | +30%                    | μA    |
|        | Mute threshold   | Maximum voltage where we must be in complete mute  |                  |      | 1.5                     | ٧     |
|        | Unmute threshold   |  | 2.5              |      |                         | V     |
|        | Mute to unmute transition voltage  |  | 0.2              | 0.3  | 0.42                    | V     |
|        | Vol  | IC in mute mode, FastMute=1<br>lout=0  |                  |      | Digital<br>GND +<br>0.1 | V     |
|        | Voh  | IC in unmute, lout=0   | VDIGITAL-<br>0.1 |      |                         | ٧     |
|        | Fast mute Resistance   | FASTMUTE=1<br>Vmutepin=1.5Volts  | 420              | 550  | 680                     | Ohm   |

### 4.3.4 Oscillator

Table 9. Oscillator

| Symbol                | Parameters                                   | Test conditions   | Min.                  | Тур.                    | Max.             | Units |  |  |  |  |  |
|-----------------------|--|---|-----------------------|-------------------------|------------------|-------|--|--|--|--|--|
| Internal osc          | Internal oscillator                          |   |                       |                         |                  |       |  |  |  |  |  |
|                       |  | PWMCLOCK=[0 1]  | 100K                  | 120                     | 140K             | KHz   |  |  |  |  |  |
| F <sub>PWM_NOM</sub>  | Switching frequency                          | PWMCLOCK=[1 0]  |                       | F <sub>PWM_NOM</sub> *2 |                  |       |  |  |  |  |  |
| L.com                 |  | PWMCLOCK=[0 0]  |                       | F <sub>PWM_NOM</sub> /2 |                  |       |  |  |  |  |  |
| CLK <sub>DC</sub>     | Duty cycle                                   |   | 48                    | 50                      | 52               | %     |  |  |  |  |  |
| V <sub>CLK_High</sub> | Maximum voltage level                        | Clock output high value<br>Load = 20Kohm and 100pF<br>to buffered SVR | V <sub>P25</sub> -0.1 |                         | V <sub>P25</sub> | V     |  |  |  |  |  |
| V <sub>CLK_Low</sub>  | Minimum voltage level                        | Clock output low value<br>Load = 20Kohm and 100pF<br>to buffered SVR  | V <sub>M25</sub> -0.1 |                         | V <sub>M25</sub> | V     |  |  |  |  |  |
| V <sub>CLK-P-P</sub>  | Peak-peak voltage                            | Load = 20Kohm and 100pF to SVR  | -10%                  | 4.7                     | +10%             | V     |  |  |  |  |  |
|                       | Dither cap charge current                    | Dither pin voltage= 2.5V  | -20%                  | 100                     | +20%             | μΑ    |  |  |  |  |  |
|                       | Dither cap discharge current                 |   | -20%                  | 100                     | +20%             | μΑ    |  |  |  |  |  |
|                       | Peak-peak dither voltage swing               |   | 1.4                   | 1.6                     | 1.7              | V     |  |  |  |  |  |
|                       | Dither external clock determination          | Voltage at the dither pin at to select external clock function        | VDIG-0.2              |                         |                  | ٧     |  |  |  |  |  |
|                       | No dither                                    | Voltage at the dither pin at which no dither will occur               |                       |                         | VDGND<br>+0.2    | V     |  |  |  |  |  |
|                       | Peak F <sub>PWM</sub> increase due to dither | Cdither=100nF   | +8                    | +10                     | +12              | %     |  |  |  |  |  |
|                       | Peak F <sub>PWM</sub> decrease due to dither | Cdither=100nF   | -8                    | -10                     | -12              | %     |  |  |  |  |  |
|                       | Triangular peak value                        |   | VGND+<br>1V           |                         | VDIG-<br>1V      |       |  |  |  |  |  |

### 4.3.5 Modulator

Table 10. Modulator

| Symbol              | Parameters           | Test conditions        | Min. | Тур. | Max. | Units |
|---------------------|----------------------|------------------------|------|------|------|-------|
| Integrator op. amp. |                      |                        |      |      |      |       |
| Int_Voff            | Input offset voltage |                        | -2.5 |      | +2.5 | mV    |
| Int_ibias           | Input bias current   | Guaranteed by design   |      |      | 500  | nA    |
| T <sub>off</sub>    | Maximum duty cycle   | V <sub>sp</sub> =1 4.4 |      |      | 1.1  | μs    |

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## 4.3.6 Gate drive and output stage control

Table 11. Gate drive and output stage control

| Symbol                 | Parameters   | Test conditions   | Min.                          | Тур.          | Max.                 | Units |
|------------------------|--|---|-------------------------------|---------------|----------------------|-------|
| V <sub>OL_LSD</sub>    | LSG low voltage                                    | I <sub>sink</sub> = 0.5A<br>I <sub>sink</sub> = 20mA              |                               |               | 1.75<br>0.080        | V     |
| V <sub>OH_LSD</sub>    | LSG high voltage                                   | I <sub>source</sub> = 0.5A<br>I <sub>source</sub> = 20mA          | 7<br>9.2                      |               |                      | ٧     |
| $V_{OL\_HSD}$          | HSG low voltage                                    | I <sub>sink</sub> = 0.5A<br>I <sub>sink</sub> = 20mA              |                               |               | VSP-7<br>VSP-<br>9.2 | ٧     |
| V <sub>OH_HSD</sub>    | HSG high voltage                                   | I <sub>source</sub> = 0.5A<br>I <sub>source</sub> = 20mA          | VSP-<br>1.75<br>VSP-<br>0.080 |               |                      | V     |
|                        | HSG low Z drive t <sub>delay</sub>                 | After a commutation   | 2                             |               | 10                   | μs    |
|                        | LSG low Z drive t <sub>delay</sub>                 | After a commutation   | 2                             |               | 10                   | μs    |
|                        | HSG HiZ sink current                               | V <sub>HSG</sub> =V <sub>SP</sub> t>5uS                           |                               |               | 150                  | mA    |
|                        | LSG HiZ source current                             | V <sub>LSG</sub> =V <sub>SM</sub> , t>5uS                         |                               |               | 150                  | mA    |
| Overcurrer             | nt sensing   |   |                               |               |                      |       |
| I <sub>limThresh</sub> | Range of I <sub>lim Trthresh</sub>                 |   | 0.3                           |               | 1.1                  | V     |
| Vilim                  | Vilim  | Engagement of the current limiting VlimitTreshold=1V w.r.t. VM2p5 | Vlim*<br>3.0                  |               | Vlim*<br>5.0         | V     |
| VIIIIII                | Vitrip   | Start of cycle by cycle current limiting                          | -15%                          | Vlim *<br>6.0 | +15%                 | V     |
| Anti-shoo t            | through  |   |                               | _             | _                    |       |
| PV <sub>GS_ON</sub>    | PFET gate voltage that will block NFET enhancement |   | -2.5                          |               |                      | V     |
| PV <sub>GS_OFF</sub>   | PFET gate voltage that will allow NFET enhancement |   |                               |               | -3.5                 | ٧     |

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Table 11. Gate drive and output stage control (continued)

| Symbol               | Parameters   | Test conditions | Min. | Тур. | Max. | Units |
|----------------------|--|-----------------|------|------|------|-------|
|                      | NFET gate voltage that will block PFET enhancement |                 | 2.5  |      |      | V     |
| NV <sub>GS_OFF</sub> | NFET gate voltage that will allow PFET enhancement |                 |      |      | 3.5  | V     |

## 4.3.7 Diagnostics

Table 12. Diagnostics

| Symbol              | Parameters                                       | Test conditions            | Min.           | Тур.                 | Max.           | Units |
|---------------------|--|----------------------------|----------------|----------------------|----------------|-------|
| Turn-on d           | iagnostics/ Power up diagn                       | ostics                     | •              | ı                    | •              |       |
|                     |  |                            | -15%           | 2.45/(3*<br>Riset)   | +15%           | mA    |
| I <sub>TEST</sub>   | Test current for short/open                      | R <sub>i</sub> set = 560hm | -15%           | 15                   | +15%           |       |
|                     | R <sub>ISET</sub> allowed range                  |                            | 5.6            |                      |                | ohm   |
| V <sub>LSSHRT</sub> | Short threshold to lower supply rail             |                            |                |                      | -Vs +1         | V     |
| V <sub>NOP</sub>    | Normal operation thresholds                      |                            | -Vs+2          |                      | -Vs+5.5        | V     |
|                     | Short to supply                                  |                            | -Vs+8          |                      |                |       |
|                     | Shorted load                                     |                            |                |                      | 6              | mV    |
|                     | Normal load                                      |                            | .025           |                      | 1              | V     |
|                     | Open load  |                            | 2              |                      |                | V     |
|                     | Test charge current                              |                            | -30%           | 10μΑ                 | +30%           | μΑ    |
| t <sub>TEST</sub>   | Test time  |                            | 60             | 80                   | 100            | ms    |
| Permanen            | nt Diagnostics                                   |                            |                |                      |                |       |
| V <sub>offACT</sub> | DC offset detected                               |                            | +-3            |                      |                | Volts |
| V <sub>offACT</sub> | DC offset not detected, normal operation allowed |                            |                |                      | +-1.2          | Volts |
| Temperati           | ure  |                            |                |                      |                |       |
| T <sub>WARN</sub>   | Chip thermal warning                             |                            | 135            | 150                  | 165            | °C    |
|                     | Chip thermal warning hysteresis                  |                            | 3              | 5                    | 7              |       |
| Т                   | Chip thermal shutdown                            |                            | 155            | 160                  | 175            | °C    |
|                     | Shutdown hysteresis                              |                            | 3              | 5                    | 7              | °C    |
|                     | External thermal warning                         |                            | -10%           | V <sub>DIG</sub> *.4 | +10%           | V     |
|                     | External thermal warning hysteresis              |                            | Vdig*0.0<br>30 |                      | Vdig*0.<br>044 | V     |

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Table 12. Diagnostics (continued)

| Symbol                 | Parameters   | Test conditions | Min.           | Тур.                  | Max.           | Units |
|------------------------|--|-----------------|----------------|-----------------------|----------------|-------|
|                        | Ext thermal shut down  |                 | -15%           | V <sub>DIG</sub> *.36 | +15%           | V     |
|                        | Ext thermal shut down hysteresis                                       |                 | Vdig*0.0<br>32 |                       | Vdig*0.<br>046 | V     |
| Supply I <sub>se</sub> | nse  |                 |                |                       |                |       |
|                        | Supply sense trip voltage  |                 | 16             | 20                    | 25             | mV    |
| l.com                  | AOUT levels that allow sensing of supply current                       |                 |                |                       | 3              | V     |
|                        | Duration of AOUT under<br>threshold to allow supply<br>current sensing |                 | -25%           | 80                    | +25%           | ms    |
| I <sub>ssenp</sub>     |  |                 | 200            |                       | 700            | μΑ    |
| I <sub>ssenM</sub>     |  |                 | -500           |                       | 500            | nA    |

# 4.4 Voltage booster

Table 13. Voltage booster

| Symbol                  | Parameters  | Test conditions                                       | Min.  | Тур. | Max.  | Units           |
|-------------------------|---|---|-------|------|-------|-----------------|
| Current mode            | e control topology  |   |       |      |       |                 |
| BST <sub>DCMAX</sub>    | Max duty cycle  |   |       |      | 88    | %               |
| BST <sub>DCMIN</sub>    | Min duty cycle  |   | 0     |      |       | %               |
| BSTREF                  | Vref  |   | -8%   | 2.5  | +8%   | V               |
| IBIAS <sub>BSTREF</sub> | V <sub>sense</sub> input bias current                         |   | -100  |      | 100   | nA              |
| V <sub>SENSE_UL</sub>   | V <sub>sense</sub> pin allowed voltage range                  |   | -0.6  | 58   |       | V               |
| BSTVGain                | Voltage-error gain<br>ΔDuty cycle/ΔBSTVSense                  |   | 0.4   | 0.8  | 1.2   | %D.C.<br>per mV |
| BSTDC <sub>NOM</sub>    | Nominal duty cycle  |   | 55    |      | 65    | %D.C.           |
| C <sub>sense_UL</sub>   | C <sub>sense</sub> pin allowed voltage range                  |   | -0.6  |      | 58    | V               |
| C <sub>sense gain</sub> | C <sub>sense</sub> gain<br>ΔDuty cycle / ΔC <sub>sense</sub>  |   | 0.120 |      | 0.350 | %D.C.<br>per mV |
|                         | V <sub>C_SENSE</sub> at max current                           | V <sub>Vsense</sub> = V <sub>reference</sub><br>DC=0% |       |      |       |                 |
| Csense <sub>Trip</sub>  | Ilimit trip point   |   | 0.220 |      | 0.440 | V               |
| T <sub>SS</sub>         | Soft-start step period<br>not yet tested (to be<br>confirmed) |   |       | 3    |       | ms              |
|                         | Soft start steps  |   |       | 16   |       |                 |

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Table 13. Voltage booster

| Symbol              | Parameters | Test conditions  | Min.     | Тур. | Max.           | Units    |
|---------------------|------------|--|----------|------|----------------|----------|
| V <sub>OH_BST</sub> |            | I <sub>source</sub> = 0.5A<br>I <sub>source</sub> = 20mA | 7<br>9.2 |      |                | V        |
| V <sub>OL_BST</sub> |            | I <sub>sink</sub> = 0.5A<br>I <sub>sink</sub> = 20mA     |          |      | 1.75V<br>0.080 | <b>V</b> |

## 4.4.1 Digital to analog converter

Table 14. Digital to analog converter

| Symbol | Parameters                                | Test conditions  | Min. | Тур. | Max. | Units |
|--------|---|--|------|------|------|-------|
|        | Dynamic range at -60dBFS                  | At output of analog filter -60dBFS input 1KHz sine tone  | 80   | 90   |      | dB    |
|        | Noise floor                               | At output of analog filter after > 25mS of -97dBFS input 20-20k Hz flat  |      |      | 20   | μV    |
|        | THD+N<br>at maximum useful input<br>level | Input=-1.5dBFS The DAC output is limited to prevent operation in regions of degraded DAC performance. This spec represents the performance at this maximum practical value |      |      | -60  | dB    |
|        | Silent Mute                               | Must engage after 25mS of <-<br>96dbFS input signal  | 20   |      | 30   | ms    |
|        | Differential output voltage               | Magnitude of -1.5dBFS sine,<br>1 KHz   | -10% | 2.1  | +10% | Vrms  |
|        | Output resistance                         |  | 1.8K | 2.5K | 2.8K | Ohms  |

## 4.4.2 I/O pin characteristics

Table 15. I/O pin characteristics

| Symbol                 | Parameters                            | Test conditions                | Min. | Тур. | Max. | Units |
|------------------------|---------------------------------------|--------------------------------|------|------|------|-------|
| I <sub>SCL/CLIP_</sub> | SCL/CLIP_L pin leakage current        |                                | -15  |      | 15   | μA    |
| I <sub>SCL/CLIP_</sub> | SCL/CLIP_L pin sink                   | V <sub>SCL/CLIP_L</sub> <375mV | 1    |      |      | mA    |
|                        | V <sub>OH</sub> , digital output pins |                                |      |      |      |       |
|                        | V <sub>OL</sub> digital output pins   |                                |      |      |      |       |
| .u.com                 | V <sub>INL</sub>                      |                                |      |      | 1.5  | V     |
|                        | V <sub>INH</sub>                      |                                | 2.3  |      |      | ٧     |
|                        | ADDR0 ADDR1 threshold low             |                                |      |      | 1    |       |
|                        | ADDR0 ADDR1 threshold high            |                                | 4    |      |      |       |

## 4.4.3 Op. amp. cells

Table 16. Op. amp. cells

| Symbol     | Parameters                             | Test conditions   | Min. | Тур. | Max. | Units |
|------------|--|---|------|------|------|-------|
| Int_OLGain | Open loop voltage gain                 | Guaranteed by design  | 80   |      |      | dB    |
| PSRR       | V <sub>SP</sub> power supply rejection | PSRR = 20*log10(Vsp/=<br>F < 10KHz V <sub>SP</sub> ripple=1Vrms<br>Guaranteed by design | -50  |      |      | dB    |
| Int_Voff   | Input offset voltage                   | Guaranteed by design  | -3   |      | 3    | mV    |
| Int_ibias  | Input bias current                     | Guaranteed by design  |      |      | 500  | nA    |

### 4.4.4 Shunt

Table 17. Shunt

| Symbol              | Parameters   | Test conditions | Min. | Тур. | Max. | Units |
|---------------------|--|-----------------|------|------|------|-------|
| I <sub>source</sub> | Source current   |                 | 70   | 100  | 130  | μΑ    |
| I <sub>sink</sub>   | Sink current   |                 | 70   | 100  | 130  | μΑ    |
| V <sub>sd</sub>     | Shunt drive current activation Vs. Mute pin voltage (the shunt current is sourced when Vmute is lower than the threshold). |                 | 0.8  |      | 1.2  | ٧     |
| V <sub>sdh</sub>    | Shunt drive current activation hysteresis  |                 | 80   |      | 140  | mV    |

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## 4.4.5 Application information

These are required parameters of the overall operation of the Cortina IC in its application circuit and will form the overall functional testing for Cortina

Table 18. Analog operating characteristics

| Symbol | Parameters    | Test conditions   | Min.         | Тур.   | Max.       | Units |
|--------|---------------|---|--------------|--------|------------|-------|
| Ų.com  |               | 1W, 100Hz, V <sub>SP</sub> =14.4<br>RI=2 ohm<br>Only modulator    |              |        | 0.5        | %     |
|        | †THD+Noise    | $4W V_{CC} = 14V \text{ and } V_{CC} = 42V$<br>$F_R = 1 00Hz$ (1) |              |        | 0.3        | %     |
|        |               | 50W F <sub>R</sub> =1kHz V <sub>CC</sub> = 42V                    |              |        | 0.4        | %     |
|        | Output noise  | V <sub>SP</sub> =14.4V (1)  |              |        | 400        | μVrms |
|        | Output offset | $V_{CC} = 14.4V$<br>$V_{CC} = 42V$                                | -100<br>-200 | 0<br>0 | 100<br>200 | mV    |
|        | Output offset | Offset modulator only (V <sub>CC</sub> =14.4V)                    | -70          | 0      | 70         | mV    |

<sup>1.</sup> Note: the measure is affected by the testing board noise.

I<sup>2</sup>C and mode control TDA7572

# 5 I<sup>2</sup>C and mode control

The Mode1 and Mode0 pins are used to enable TDA7572. These perform the function of bringing the IC out of standby (typically handled by a single standby pin on most audio IC's) as well as determining if the I<sup>2</sup>C bus is active or if power-up Diagnostics shall automatically occurs.

The Auto-mute Voltage pin is used to provide an under-voltage-lockout for the IC. Using a resistor divider between V2P5 and SVR a series of comparator prevent the IC from power-up further until sufficient voltage is present at VSP and SVR(equal to GND in the split supply case. Once this voltage requirement is met, the chip is forced into mute (a special, direct form of mute that does not use or act upon the MUTE pin) under a second, higher voltage threshold is met. At this point the IC performs its normal power-up, controlled by the state of the MODE pins and the various configuration pins. Refer to the under-voltage lockout (UVLO) section of the documentation for details on these thresholds.

The Auto-mute Voltage pin is also used to provide an over-voltage shutdown based on absolute voltage of VSP-VSM.

Table 19. Power-up mode control

| Mode1 | Mode0 | State/function  |
|-------|-------|---|
| 0     | 0     | Standby, or "Off"   |
| 0     | 1     | NO I <sup>2</sup> C BUS mode<br>TDA7572 enabled<br>Configuration defaults read from pin<br>I <sup>2</sup> C disabled<br>Power-Up-Diagnostics disabled   |
| 1     | 1     | I <sup>2</sup> C BUS mode TDA7572 enabled I <sup>2</sup> C enabled Power-Up-Diagnostics disabled TDA7572 enabled Configuration defaults read from pins I <sup>2</sup> C disabled Power-Up-Diagnostics enabled |
| 1     | 0     | DIAGNOSTIC mode TDA7572 enabled Configuration defaults read from pins I <sup>2</sup> C disabled Power-Up-Diagnostics enabled  |

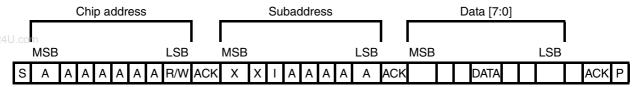
When I<sup>2</sup>C bus is active, determined by the Mode0 and Mode1 pins, any operating mode of the IC may be modified and diagnostics may be controlled and results read back.

TDA7572 I<sup>2</sup>C and mode control

The protocol used for the bus is the following and comprises:

- a start condition (S)
- a chip address byte (the LSB bit determines read / write transmission)
- a subaddress byte
- a sequence of data (N-bytes + acknowledge)
- a stop condition (P)

#### Table 20. Addresses



S = Start

 $R/W = "0" -> Receive-Mode (Chip could be programmed by <math>\mu P$ )

"1" -> Transmission-Mode (Data could be received by  $\mu P$ )

I = Auto increment - when 1, the address is automatically increased for each byte transferred

X: not used

ACK = Acknowledge

P = Stop

MAX CLOCK SPEED 500kbits/s

The I<sup>2</sup>C address is user determined by pins ADDR1 and ADDR0. See table below:

Table 21. I<sup>2</sup>C chip address

| MSB |            |            |    |    |       |       | LSB         |
|-----|------------|------------|----|----|-------|-------|-------------|
| A6  | <b>A</b> 5 | <b>A</b> 4 | А3 | A2 | A1    | Α0    | R/ <u>W</u> |
| 0   | 1          | 0          | 0  | 0  | ADDR1 | ADDR0 | Х           |

#### Write procedure:

Two possible write procedures are possible:

- 1. without increment: the I bit is set to 0 and the register is addressed by the subaddress. Only this register is written by the data following the subaddress byte.
- with increment: the I bit is set to 1 and the first register read is the one addressed by subaddress. Are written the register from this address up to stop bit or the reaching of last register.

Example of write instruction with increment:

|   | Device<br>Address | R/W |   | Register<br>Address |   | DATA 1 |   |     |   |     | DAT | A 2 |   |     | DAT | Γ <b>A</b> n |   |   |
|---|-------------------|-----|---|---------------------|---|--------|---|-----|---|-----|-----|-----|---|-----|-----|--------------|---|---|
| S | 0011000           | 0   | Α | ADDR                | Α | MS1    | Α | LS1 | Α | MS2 | Α   | LS2 | Α | MSn | Α   | LSn          | Α | Р |

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I<sup>2</sup>C and mode control TDA7572

#### **Read Procedure:**

Two possible read procedures are possible:

1. without increment: the I bit is set to 0 and the register is addressed by the subaddress sent in the previous write procedure. Only this register is written by the data following the address.

2. with increment: the I bit is set to 1 and the first register read is the one addressed by subaddress sent in the previous write procedure. Are written the register from this address up to stop bit or the reaching of last register.

Example of read instruction with increment and previous addressing by write instruction and restart bit (Sr)

t4U com

|   | Device<br>Address | I K/W |   | Register<br>Address |   |    | Device<br>Address | H/W |   | DATA 1 |   | DATA 2 |   |     |   |     | DA <sup>-</sup> | ΓA n |   |     |    |   |
|---|-------------------|-------|---|---------------------|---|----|-------------------|-----|---|--------|---|--------|---|-----|---|-----|-----------------|------|---|-----|----|---|
| S | 0011000           | 0     | Α | ADDR                | Α | Sr | 0011000           | 1   | Α | MS1    | Α | LS1    | Α | MS2 | Α | LS2 | Α               | MSn  | Α | LSn | NA | Р |

In the following tables are reported the meaning of each I<sup>2</sup>C bus present in the device.



TDA7572 I<sup>2</sup>C and mode control

# 5.1 Input control register

Subaddress: XXI00001.

Table 22. Input control register

| MSB                   | <u> </u>              | JOHN 10               |                          |                       |                                  |                          | LSB                   |   |
|-----------------------|-----------------------|-----------------------|--------------------------|-----------------------|----------------------------------|--------------------------|-----------------------|---|
| D <sub>7</sub><br>R/W | D <sub>6</sub><br>R/W | D <sub>5</sub><br>R/W | D <sub>4</sub><br>R/W    | D <sub>3</sub><br>R/W | D <sub>2</sub><br>R/W            | D <sub>1</sub><br>R/W    | D <sub>0</sub><br>R/W | Function  |
| <b>1</b><br>com       | 1                     | 1                     | 1                        | 0                     | 0                                | 0                        | 1                     | Power-up default, I <sup>2</sup> C enabled                              |
|                       | ckSel<br>→ [11]       | (pin)=1               | ckSel<br>→ [11]<br>ckSel | (pin)=1               | Enable $\rightarrow$ [01] Enable | Read<br>from<br>PLL/Gain | 0                     | Power-up default I <sup>2</sup> C disabled                              |
|                       | → [10]                |                       | → [10]                   |                       | D → [00]                         | pin                      |                       |   |
|                       |                       |                       |                          |                       |                                  |                          | 1<br>0                | Mute<br>Mute<br>Play  |
|                       |                       |                       |                          |                       |                                  | 0                        |                       | INLEVEL0<br>Low Gain<br>High Gain                                       |
|                       |                       |                       |                          | 0<br>0                | 0                                |                          |                       | Gain table Compressor disabled THD=0.02; Nb. step=1 THD=3.0; Nb. step=2 |
|                       |                       |                       |                          | 1                     | 0                                |                          |                       | THD=0.02; Nb. step=1 THD=3.0; Nb. step=2 THD=5.0; Nb. step=3 Not used   |
|                       |                       | 0<br>0<br>1<br>1      | 0<br>1<br>0              |                       |                                  |                          |                       | Release<br>(400kHz clock)<br>20.48ms<br>40.96ms<br>81.92ms<br>163.4ms   |
| 0<br>0<br>1<br>1      | 0<br>1<br>0           |                       |                          |                       |                                  |                          |                       | Attack<br>(400kHz clock)<br>160μs<br>320μs<br>640μs<br>1.28ms           |

I<sup>2</sup>C and mode control TDA7572

# 5.2 Faults 1 register

Subaddress: XXI 00010.

Table 23. Faults 1 register

| MSB                      |                          |                          |                       |                          |                          |                          | LSB                      |   |
|--------------------------|--------------------------|--------------------------|-----------------------|--------------------------|--------------------------|--------------------------|--------------------------|---|
| D <sub>7</sub><br>R/W1TC | D <sub>6</sub><br>R/W1TC | D <sub>5</sub><br>R/W1TC | D <sub>4</sub><br>R/W | D <sub>3</sub><br>R/W1TC | D <sub>2</sub><br>R/W1TC | D <sub>1</sub><br>R/W1TC | D <sub>0</sub><br>R/W1TC | Function  |
| U.com                    |                          |                          | 0                     | 0                        | 0                        | 0                        | 0                        | Power-up<br>default                             |
|                          |                          |                          |                       |                          |                          |                          |                          | GNDshort  |
|                          |                          |                          |                       |                          |                          |                          | 0<br>1                   | Short to ground detected                        |
|                          |                          |                          |                       |                          |                          |                          |                          | V <sub>CC</sub> short                           |
|                          |                          |                          |                       |                          |                          | 0<br>1                   |                          | Short to a "Vcc" detected                       |
|                          |                          |                          |                       |                          |                          |                          |                          | Open/offset                                     |
|                          |                          |                          |                       |                          | 0<br>1                   |                          |                          | Open load detected during                       |
|                          |                          |                          |                       |                          |                          |                          |                          | LOADshort                                       |
|                          |                          |                          |                       | 0<br>1                   |                          |                          |                          | Short across the load detected                  |
|                          |                          |                          | 0                     |                          |                          |                          |                          | <b>DiagnENB</b> Diagnostic disabled or finished |
|                          |                          |                          | 1                     |                          |                          |                          |                          | To run the Diagnostic/diagnostic in progress    |
|                          |                          |                          |                       |                          |                          |                          |                          | UVLO flag<br>UVLO event                         |
|                          |                          |                          |                       |                          |                          |                          |                          | NOT USED  |
|                          |                          |                          |                       |                          |                          |                          |                          | NOT USED  |

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# 5.3 Faults 2 register

Subaddress: XXI 00011.

Table 24. Faults 2 register

| MSB            |                |                          |                          |                          |                          |                          | LSB                      |  |
|----------------|----------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|--|
| D <sub>7</sub> | D <sub>6</sub> | D <sub>5</sub><br>R/W1TC | D <sub>4</sub><br>R/W1TC | D <sub>3</sub><br>R/W1TC | D <sub>2</sub><br>R/W1TC | D <sub>1</sub><br>R/W1TC | D <sub>0</sub><br>R/W1TC | Function                                       |
| J.com          |                | 0                        | 0                        | 0                        | 0                        | 0                        | 0                        | Power-up<br>default                            |
|                |                |                          |                          |                          |                          |                          |                          | Clip   |
|                |                |                          |                          |                          |                          |                          | 0<br>1                   | Clipping of modulator and/or preamplifier      |
|                |                |                          |                          |                          |                          |                          |                          | Offset   |
|                |                |                          |                          |                          |                          | 0<br>1                   |                          | Offset detected                                |
|                |                |                          |                          |                          |                          |                          |                          | IsenTrip                                       |
|                |                |                          |                          |                          | 0<br>1                   |                          |                          | Power supply current threshold trespass        |
|                |                |                          |                          |                          |                          |                          |                          | loutTrip                                       |
|                |                |                          |                          | 0<br>1                   |                          |                          |                          | Output stage current limiting has been enabled |
|                |                |                          |                          |                          |                          |                          |                          | ExtTwarn                                       |
|                |                |                          | 0<br>1                   |                          |                          |                          |                          | External thermal warning threshold trespassed  |
|                |                |                          |                          |                          |                          |                          |                          | TJwarn   |
|                |                | 0<br>1                   |                          |                          |                          |                          |                          | Internal thermal warning threshold trespassed  |
|                |                |                          |                          |                          |                          |                          |                          | NOT USED                                       |
|                |                |                          |                          |                          |                          |                          |                          | NOT USED                                       |

I<sup>2</sup>C and mode control TDA7572

# 5.4 Control register

Subaddress: XXI 00100.

Table 25. Control register

| MSB                   |                       |                       |                       |                       |                       |                | LSB                   |  |
|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|----------------|-----------------------|--|
| D <sub>7</sub><br>R/W | D <sub>6</sub><br>R/W | D <sub>5</sub><br>R/W | D <sub>4</sub><br>R/W | D <sub>3</sub><br>R/W | D <sub>2</sub><br>R/W | D <sub>1</sub> | D <sub>0</sub><br>R/W | Function   |
| 0<br>U.com            | 0                     | 0                     | 0                     | 1                     | 0                     | 1              | 0                     | Power-up default I <sup>2</sup> C enabled  |
| 0                     | 0                     | 0                     | 0                     | 1                     | SDA/SCR_ENB           | 1              | 0                     | Power-up Default I <sup>2</sup> C disabled   |
|                       |                       |                       |                       |                       |                       |                | 0                     | Mute speed<br>Slow Mute<br>Fast Mute   |
|                       |                       |                       |                       |                       |                       |                |                       | OffsetENB  |
|                       |                       |                       |                       |                       |                       | 0<br>1         |                       | Enable the offset detection  |
|                       |                       |                       |                       |                       | 0<br>1                |                |                       | PassFET Control ENB Enable the SCR intervention  |
|                       |                       |                       |                       | _                     |                       |                |                       | BOOST  |
|                       |                       |                       |                       | 0<br>1                |                       |                |                       | Enable the step-up   |
|                       |                       |                       | 0                     |                       |                       |                |                       | L/R Read left channel from I <sup>2</sup> S Read right channel from I <sup>2</sup> S                               |
|                       |                       | 0                     |                       |                       |                       |                |                       | Fratio1<br>Fs = 96 kHz<br>Fs= 192 kHz  |
|                       | 0                     |                       |                       |                       |                       |                |                       | Fratio0 Bass range digital input Fs= 38 to 48 kHz Full band digital input (Fs=96 or 192 kHz selectable by Fratio1) |
| _                     |                       |                       |                       |                       |                       |                |                       | DACEnb   |
| 0                     |                       |                       |                       |                       |                       |                |                       | Enable DAC operation   |

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# 5.5 Modulator register

Subaddress: XXI 00101.

Table 26. Modulator register

| MSB                   |                       |                       |                       |                       |                       |                       | LSB                   |  |
|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|--|
| D <sub>7</sub><br>R/W | D <sub>6</sub><br>R/W | D <sub>5</sub><br>R/W | D <sub>4</sub><br>R/W | D <sub>3</sub><br>R/W | D <sub>2</sub><br>R/W | D <sub>1</sub><br>R/W | D <sub>0</sub><br>R/W | Function   |
| 0<br>U.com            | 1                     | 1                     | 0                     | 0                     | 1                     |                       | 0                     | Power-up default I <sup>2</sup> C disabled                 |
| 0                     | 1                     | 0                     | 0                     | 0                     | SCL/InLevel1 pin      |                       | 1                     | Power-up default I <sup>2</sup> C enabled                  |
|                       |                       |                       |                       |                       |                       |                       | 0<br>1                | SHUNT<br>Turn-on shunt                                     |
|                       |                       |                       |                       |                       |                       |                       |                       | NOT USED   |
|                       |                       |                       |                       |                       |                       |                       |                       | INLEVEL1   |
|                       |                       |                       |                       |                       | 0<br>1                |                       |                       | High level couple  |
|                       |                       |                       | 0                     |                       |                       |                       |                       | DAC synchronization Synchronize the modulator with the DAC |
|                       |                       |                       |                       |                       |                       |                       |                       | SVR  |
|                       |                       |                       | 0<br>1                |                       |                       |                       |                       | Turn On the charge of SVR                                  |
|                       |                       | 0<br>1                |                       |                       |                       |                       |                       | Tristate Tristate modulator                                |
| 0<br>0<br>1<br>1      | 0<br>1<br>0<br>1      |                       |                       |                       |                       |                       |                       | PWMClock<br>55kHz<br>110kHz<br>220kHz<br>110kHz            |

I<sup>2</sup>C and mode control TDA7572

# 5.6 Testing register

Subaddress: XXI 00110.

Table 27. Testing register

|      | MSB                   |                       |                       |                       |                       |                       |                       | LSB                   |   |
|------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|---|
|      | D <sub>7</sub><br>R/W | D <sub>6</sub><br>R/W | D <sub>5</sub><br>R/W | D <sub>4</sub><br>R/W | D <sub>3</sub><br>R/W | D <sub>2</sub><br>R/W | D <sub>1</sub><br>R/W | D <sub>0</sub><br>R/W | Function  |
| ·U.c | om                    |                       |                       |                       | 0                     | 0                     | 0                     | 0                     | Power-up<br>default   |
|      |                       |                       |                       |                       |                       |                       |                       |                       | Or ZC   |
|      |                       |                       |                       |                       |                       |                       |                       | 0<br>1                | (nIN xnor pIN) or (nOUT xnor pOUT) are put on the clipping output |
|      |                       |                       |                       |                       |                       |                       |                       |                       | Ramp  |
|      |                       |                       |                       |                       |                       |                       | 0<br>1                |                       | Generate a ramp on the compressor gain                            |
|      |                       |                       |                       |                       |                       |                       |                       |                       | TestDriving   |
|      |                       |                       |                       |                       |                       | 0<br>1                |                       |                       | Turn off limitation of driving current for the external MOS       |
|      |                       |                       |                       |                       |                       |                       |                       |                       | Fast  |
|      |                       |                       |                       |                       | 0<br>1                |                       |                       |                       | All time constant used in the logic block are devided by 100      |
|      |                       |                       |                       |                       |                       |                       |                       |                       | Not used  |
|      |                       |                       |                       |                       |                       |                       |                       |                       | Not used  |

### 6 Input stage and gain compressor

#### 6.1 Input stage

The input stage accepts differential analog audio and provides a single ended output that is referenced to SVR, a slowly changing reference signal that is close to  $V_{CC/2}$ . This signal is present on the pin 6 (SVR). Four input stage gains are selectable, chosen such that input signal levels of either  $2V_{RMS}$ ,  $2.6V_{RMS}$ ,  $7V_{RMS}$ , or  $9.7V_{RMS}$  will provide full scale unclipped output swing of this stage.

The variable gain is realized by a single ended input attenuator (with respect to SVR), such that both differential and common-mode voltages are attenuated, and by, mean of a reconfiguration of the Op-Amp feedback.

These are controlled by two bits, one controlling the input attenuator, and the other controlling the Op-Amp configuration. The bits INLEVEL0 in the InputControl register (register addr 1, bit 1) and INLEVEL1 in the Modulator register (register addr. 5, bit 2) determine the gain selection. The default value of INLEVEL0 and INLEVEL1 bits are determined by the voltage levels at power-up on pins PLL/INLEVEL0 (pin 63) pin and SCL/INLEVEL1 (pin 62) respectively allowing gain selection without the requirement of an I<sup>2</sup>C bus. INLEVEL0 controls the input attenuator, and INLEVEL1 controls the configuration of the feedback around the op. amp.

INP - pin 12 : positive input
INM - pin 13 : negative input

AOUT - pin 14 : output

SCL/INLEVEL1 - pin62 : gain selection bit 1
PLL/INLEVEL0 - pin63 : gain selection bit 0

This stage is powered from  $\pm 2.5$ Volts, centered around SVR. Output swing is nominally  $\pm 2$  volts. The input common mode range is a function of the gain setting, the electrical parameters section must be consulted for details. It is expected that the inputs will be ac coupled, and because of this consideration must be given to the rate of change of SVR, as rapid changes to SVR could cause the inputs of this amplifier to run out of common mode range. i.e. the input decoupling capacitors can not charge fast enough to keep up with SVR

### 6.2 Gain compressor

A gain compressor is integrated in the front end of this stage, which provides up to 16dB of differential attenuation in approximately 0.5dB steps, varying somewhat depending on gain configuration. Compressor aggressiveness is programmable by the I<sup>2</sup>C data/AttackSel pin (providing a choice from two attack-time/decay-time pairs) in non-I<sup>2</sup>C bus mode, or by I<sup>2</sup>C bus with 2 bits each for attack and decay and 2 bits for the distortion-to-attenuation table. These are bits ATTACK[1:0], DECAY[1:0], and TABLE[1:0] in the InputControl register. The ADDR1/CompEnable pin is used in non-I<sup>2</sup>C mode to enable or disable gain compression entirely.

The gain compressor operates by monitoring the estimated in THD due to clipping, over-modulation or over-current and commanding a change in the input attenuation based on the THD estimate. The input attenuator has 32 discrete steps. THD is estimated by measuring the time period between zero crossings where there is no clipping and the time when there

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is clipping during that period. The THD estimate is calculated from the ratio between these times. Clipping means are any of the following conditions occurred: maximum modulation reached, output current limiting active, or voltage clipping at the AOUT pin. These are used to estimate THD, which is then mapped to a desired number of discrete steps of gain reduction. Attenuation is then changed at the next zero crossing of the signal at the Input Stage block

The attack time sets the minimum time allowed between gain reductions. At low frequency signals, where the time between zero crossings is greater than the attack time, the attack rate is dictated by the signal frequency, rather than this setting. Similarly, the decay time sets the minimum time allowed between gain increases, with the same caveats about rate dictated by the signal frequency.

The major tuning control here is the distortion-to-attenuation lookup table. It will determine how aggressively to operate and thus the relative amount of audible artifact. Decay time adjustment can be varied for audible effect and to mange average power.

Following are reported the correspondence between I<sup>2</sup>C bus registers and coefficients for Attack and decay time. The first table reports the one for compressor setting:

#### 6.2.1 Setting in I<sup>2</sup>C bus mode

**GainTable[1:0]:** Selects the distortion versus gain step size table to be used, including the ability to disable the gain compressor.

GainTable [1:0] Pseudo THD,% / T2/T1 ratio Number of gain steps 00 Gain compressor disabled 0.02 1 01 2 3.0 0.02 1 2 10 3.0 5.0 3 0.02 1 2 3.0 11 3 5.0 15.0 4

Table 28. Distortion versus gain step size

**RELEASE[1:0]:** Sets the maximum release rate of the gain compressor according to the table below:

Table 29. Sets the maximum release rate of the gain compressor

| Release [1:0] | Clock counts    | Nominal time at 400KHz clock |
|---------------|-----------------|------------------------------|
| 00            | 2 <sup>13</sup> | 20.48ms                      |
| 01            | 2 <sup>14</sup> | 40.96ms                      |
| 10            | 2 <sup>15</sup> | 81.92ms                      |
| 11            | 2 <sup>16</sup> | 163.4ms                      |

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**ATTACK[1:0]:** Sets the maximum Attack rate of the gain compressor according to the table below:

Table 30. Sets the maximum attack rate of the gain compressor

| Attack [1:0] | Clock counts   | Nominal time at 400KHz clock |
|--------------|----------------|------------------------------|
| 00           | 2 <sup>6</sup> | 160µs                        |
| 01           | 2 <sup>7</sup> | 320µs                        |
| 10           | 2 <sup>8</sup> | 640µs                        |
| 11           | 2 <sup>9</sup> | 1.28ms                       |

Setting in NOI<sup>2</sup>CBUS mode:

I<sup>2</sup>CDATA/AttackSel - pin 51 -> Attack/release rate selection

ADDR1/CompEnable - pin 54 -> Gain compression effort selection

Table 31. Attack/release rate and gain compression effort selection

| INPUT PIN/VALUE | DGND                                      | VDIG                                      |
|-----------------|---|---|
| Pin 51          | Attack[1:0] = "10"<br>Release[1:0] = "10" | Attack[1:0] = "11"<br>Release[1:0] = "11" |
| Pin 54          | GainTable[1:0]="00"                       | GainTable[1:0]="01"                       |

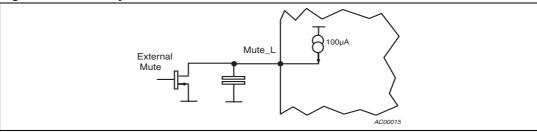
#### 6.2.2 Soft-mute function, without pre-limiter

Well-behaved over-modulation protection and current-limiting allow this IC to not require a pre-limiter before the modulator. This allows the amplifier to always take advantage of the available supply voltage. A limited output voltage can be done in a crude manner by using AOUT's max output swing, and counting on its clipping signal to drive the compressor.

A soft mute/unmute is incorporated at AOUT. It works by slowly muxing AOUT from the input signal to SVR. In this way, dc offsets occurring in any upstream stages are kept inaudible. The mux slew time is determined by the voltage slew rate at the MUTE\_L pin (pin 10), which is asserted low. Mute can by driven either be by external means, or controlled by I2C command.

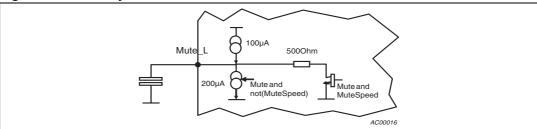
The MUTE bit, present in the input control register (D0, InputControl register), controls muting by discharging or charging the MUTE\_L pin. The default value for this bit for NOI2C mode is 0 that lead to a charging of mute cap. Abrupt muting is available by use of the MuteSpeed bit. When MuteSpeed is asserted, MUTE\_L is rapidly charged and discharged by a small resistance (approximately 500 ohms). In the pictures below are reported the two application circuits and the internal circuitry of mute correspondent to.

Figure 3. Mute by external command



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Figure 4. Mute by I<sup>2</sup>C bus command



Note:

when the modulator is set in TRISTATE the mute pin is fast-discharged by the fast-mute internal circuitry. When the modulator is take back out of TRISTATE the preamplifier is put in play back by a fast un-mute transient.

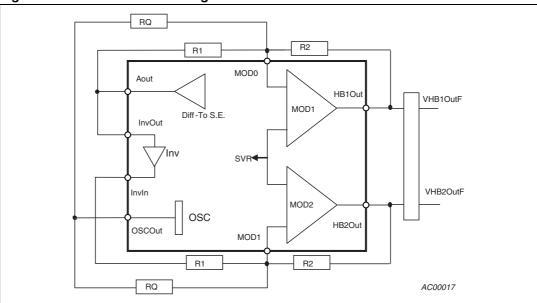
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TDA7572 Modulator

#### 7 Modulator

The modulator PWM is the main function of device. Two modulators are provided which are operated independently but configured for bridged mono operations. They are synchronized by virtue of the common clock that drives them and operate as a three-state modulator (phase shifting PWM modulation type) when the audio is inverted going to one modulator. This inversion is accommodated by a dedicated inverter block present between the InvIn and InvOut pin.

Figure 5. Modulator block diagram



The above scheme reports the application circuits and internal block involved in the PWM modulator. The analog signal is differential to single ended converted by the amplifier. The signal obtained is inserted as current in the virtual ground of modulator MOD0. The conversion is obtained trough R1 resistor. The same signal, output of AOUT, is inverted and inserted in the virtual ground MOD1 through the resistor R1.

In order to obtain a PWM signal a square wave is inserted in both MOD0 and MOD1 through the RQ resistor. The Gain of Modulator is equal to the ratio of R1/R2. In Order to choose the value of RQ has to take into account the stability of modulator, guarantee if the following relation is respected:

Equation 1 
$$\frac{VP2.5}{RQ} > \frac{VAOUTmax}{R1} + \frac{VSP - VSVR}{R2}$$

Clocked PWM modulators using an integrated T-network double integrator are implemented. The end user has the ability to trade distortion for EMI by switching faster or slower, controlled by PWMClock[1:0] in the modulator register.

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Modulator TDA7572

Table 32. PWMClock table

| PWMClock [1:0] | Ratio               | Nominal frequency |
|----------------|---------------------|-------------------|
| 00             | F <sub>NOM</sub> /2 | 55KHz             |
| 01             | F <sub>NOM</sub>    | 110KHz            |
| 10             | F <sub>NOM</sub> *2 | 220KHz            |
| 11             | F <sub>NOM</sub>    | 110KHz            |

Pulse injection is being used with the clocked PWM scheme to prevent missing pulses from an over-modulation condition. The minimum pulse width is dynamically determined by looking at the delay from the comparator output to the actual switching of the FET stage. This delay is used to extend any pulses from the modulator that would otherwise be too short. Circuitry is provided to keep the integrator hovering near the level at which limiting first occurred, which prevents transients once we leave the over modulation condition. This is done by summing in a current that is proportional to the amount of time that the pulse is extended.

Since only three- state modulation is supported, it may prove necessary to slightly delay the clock going to one modulator to prevent the noise from the switching of one modulator affecting the second modulator when there is no audio input. This can be done with a small RC on the clock feeding one modulator. The same result could be obtained adding the RC on the feedback feeding one modulator.

The reference voltage of the modulator changes from SVR at it's input, to Vcc/2 at its output. This allows output signal to be centered between the supply rails, increasing unclipped output voltage swing by preventing asymmetric clipping. This is accomplished using the LVLSFT pin, as described in the previous paragraph. It has been pointed out that there is potential for abrupt transients at the output stage, as this scheme will attempt to have the outputs track VCC/2, while it may be better for avoiding pops to have them rise slowly with SVR. The end user needs to make this decision by making or not the connection between HVCC and LVLSFT pin. Will not be present pop noise in a system with perfect symmetry between the two modulators branch. Pop noise will rise with increasing of asymmetry.

#### 7.1 FET drive

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Gate drive circuits are provided to drive complementary external FETS. An internal regulator to supply the low side gate drivers provides a voltage 10V above VSM. This fully enhances the FETs without exceeding their  $V_{GS}$  limits. A separate regulator 10V below  $V_{SP}$  is used for the high side gate drivers.

Shoot-through is prevented by sensing  $V_{GS}$  of each FET with a dedicated sense line (GateSensing), and blocking the opposite FET turn-on if the active FET in a ½ bridge has a  $|V_{GS}| > |V_{Threshold}|$ . This allows discrete components to be used to adjust gate charging without concern over shoot-through.

The drivers are capable to provide high current for a short time (about 5µs) and a lower current after this time(~150mA). This is done to give enough charge current at the commutation and avoid short-cut overcurrent.

The  $V_{DS}$  of the enhanced FET of each ½ bridge is used monitor current and detect overcurrent condition. The sensed  $V_{DS}$  signal is blanked such that sensing is only active when the FET is enhanced and any turn on transients have settled. There are two type of overcurrent intervention: current limitation, cycle-by-cycle limitation. The current limitation

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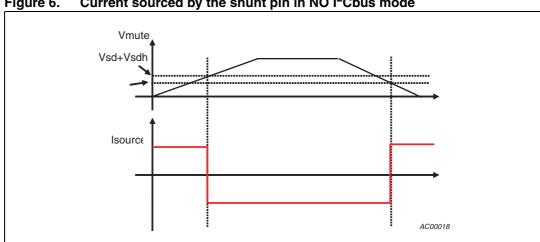
**TDA7572** Modulator

> consists in a clipping of current when the first threshold for  $V_{\text{DS}}$  is trespassed. It is obtained by sink or source current to the virtual ground of modulator integrator. The cycle-by-cycle limitation is a strong limitation. If the second  $V_{DS}$  threshold is trespassed for more than about 2µs the half bridge is tri-stated. If this condition persists for more then four PWM periods the modulator is definitely tri-stated. It is possible setting the threshold V<sub>DS</sub> voltage for the current limiting by the pin IlimitThreshold: the first threshold is the value voltage value of this pin (referred to VN2.5), the second one is the same value multiply by the factor 1.5.

#### 7.2 **ANTI-POP** shunt driver

The device is provided by a driver able to control an anti-pop shunt MOS which is connectable in series or in parallel to the load. During the mute-to-play or play-to-mute transition an external MOS is able to disconnect (MOS in series) or short (MOS in parallel) the speaker in order to reduce the audible pop noise.

The shunt driver is able to source or sink a predefined current (see Table 17). The following diagram reports the temporal behave of current at the shunt pin respect to the voltage on the mute pin in NOI<sup>2</sup>CBUS mode.



Current sourced by the shunt pin in NO I<sup>2</sup>Cbus mode Figure 6.

In I<sup>2</sup>Cbus mode it is possible to change the driver current direction only by change the bit D0 of byte 5. When the bit is set to 1 the current is sourced. By default the current is sourced.

DAC TDA7572

#### 8 DAC

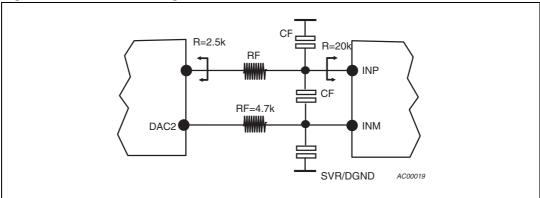
A one channel DAC is provided. A balance between die area and functionality has been made - the interpolator function required for full bandwidth operation has been off-loaded to an external DSP. This allows Bass-only operation of the DAC without any processing assistance, while full bandwidth audio requires external interpolation assistance.

The DAC has a differential output:

- positive output DAC1(32)
- negative output DAC2(31)

On these pins are present a four level squared wave, composed by the differences of two PWM wave have one an amplitude 16 times lower than the other. The output voltage on DAC1 and DAC2 is compatible to the digital supply VDIG.

Figure 7. DAC circuit diagram



where is filtered by means of capacitors and put in the AOUT Differential to single-ended input, as reported in the picture above. The maximum signal present output of converter is 1.4 Vrms. The setting to use for the Diff-to-SE converter is Gain= -3dB (INLEVEL1=0,INLEVEL0=0).

Communication is through a standard I<sup>2</sup>S port. I<sup>2</sup>C is available too.

Acting on the I<sup>2</sup>C Control registers it is possible turn-on the DAC (DACEnb) and choose the configuration (Fratio(1:0)). With Fratio = "00"/"01" the configuration is for bass only. The Input sample frequency is 48kHz (Fs). In case of Fratio = "10" the configuration is for full band. The input sample rate for this case is 96kHz (Fs) and the first x2 interpolator has to be implemented off-line in the DSP. A well checked structure to realize could be the following:

**Oversampling** Increasing word rate from Fs to 2Fs.

Filter Type Remez filter, half band

Taps, bit 57, 12

Attenuation 50db attenuation out of 0.55Fs

Coefficients It is an Half-Band filter then we have only 15

coefficients (see following)

Coefficients: -11,11,-16,22,-30,40,-53,69,-91,122,-168,247,-426,1300,2047,1300,....

TDA7572 DAC

In case of Fratio = "11" the configuration is still for full band. The input sample rate for this case is 192kHz (Fs) and the first x4 interpolator has to be implemented off-line in the DSP. For the first x2 interpolator could be used the precedent, for the second one should be used the following:

**Oversampling** Increasing word rate from 2Fs to 4Fs.

Filter Type Remez filter, half band

Taps, bit 7, 12

Attenuation 50db attenuation out of 0.77\*(2Fs)

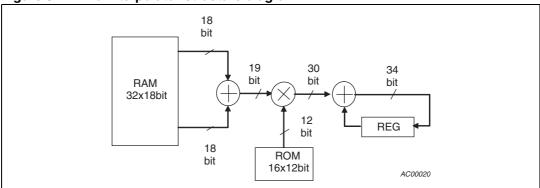
Coefficients It is an Half-Band filter then we have only 3

coefficients (see following)

Coefficients: -190, 1199,2047,...

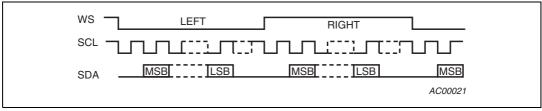
To implement the first interpolator are necessary 28 memory access, 14 sum and 14 MAC (multiply with accumulation) at rate Fs. For the second one are, instead, enough 4 memory access, 2 sum and 2 MAC at rate 2Fs. In the following schematic is reported the structure for the two interpolator eventually to implement in the DSP.

Figure 8. Two interpolator structure diagram



The I<sup>2</sup>S format is used to transfer audio samples:

Figure 9. I<sup>2</sup>S format diagram



Where the WS is a clock at frequency Fs(48,96,192kHz) and discern which channel is transferred, where the SCL is the interface clock at 64\*Fs(3.07, 6.14, 12.29MHz). The SDA are the bit transferred, 32 for each channel. Only the first 18 bits are taken into account and only one channel. The Control register bit L/R selects the channel amplified.

The internal clock used to clock the DAC logic is obtained from the PLL that lock to the I2S clock present on pin SCL. In order to work the PLL needs a RC series network connected to pin PLL/INLEVEL0 (pin 44). Optimal value are C=100nF, R=33Ohm with in parallel an 1.8pF capacitance

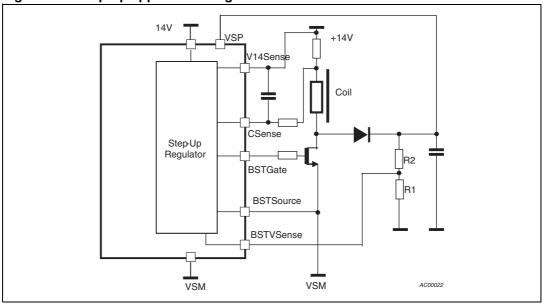
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**TDA7572** Step-up

#### 9 Step-up

A current boost controller is provided to allow high power operation in the 14V automotive environment. This is a clocked PWM, current mode control block that drives an external NFET. Following is present the application circuits.

Figure 10. Step-up application diagram



In the Step-up implemented is present a current control loop and a voltage one to fix the output voltage. On the pin BSTVSense is reported the voltage VSP except for the gain of Step-up, here imposed by the ratio R1 and R2. To improve stability, response time and inductor requirements, an inner current control loop has been implemented. The inductor parasitic resistance will be an adequate current sensor, and it is expected that with an RC could be cancelled the zero of the boost inductor. Instead of use the parasitic resistor of inductor a series sensing resistor could be used. The current sensing is take out by the pins V14Sense and Csense.

To avoid destructive startup currents, soft startup is provided which functions by increasing the allowed current limit using 4 steps roughly 4ms apart.

An overcurrent condition is declared if there is an extended period of high current.

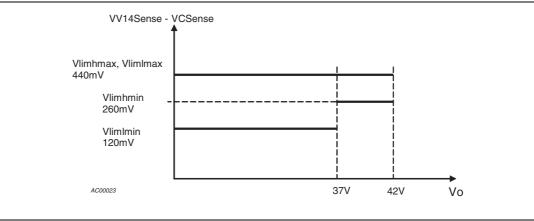
Excessive current is detected (by monitoring the voltage across Csense and V14Sense pins) for a period exceeding 20ms, which are considered to be caused by a fault condition, are detected as Csense exceeding a voltage threshold and are handled by forcing a restart of the soft start sequence when over-current is declared. Following are reported the threshold of current limiting.

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TDA7572 Step-up

Figure 11. Threshold of current limiting diagram



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The I<sup>2</sup>C bus register that is set for default to "habilitation" enables the step up. In case of 14V operation or split supply the step-up and no i2c bus mode the step-up is disabled by connects the BSTVSense pin to a reference of at least five volts over VSM.

During the testing phase the digital test mode is entered by put Csense pin at least 3V under 14V pin.

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Diagnostics TDA7572

### 10 Diagnostics

Diagnostics are grouped into two categories, those performed only during standby, and those available during amplifier operation.

When Mode[1:0] indicate the I<sup>2</sup>C is active, the RunDiag bit must be set (by an I<sup>2</sup>C write to the Faults1 register) to initiate diagnostics.

When Mode[1:0]indicate the I<sup>2</sup>C is not active, the state of Mode[1:0] are further decoded to determine if the diagnostics should be run automatically during power-up

Diagnostics performed during power-up (Power Up Diagnostic or PUD, sometimes called "Turn-on-diagnostics") are:

- 1. Output shorted to ground
- 2. Output shorted to Vs
- 3. Shorted transducer
- 4. Open Transducer

During operation the following conditions are continuously monitored:

- DC offset across the speaker
- 2. Die temperature
- 3. External temperature
- 4. Output Clipping
- 5. Output overcurrent
- 6. Power supply overcurrent

Faults are reported in a simple manner for bus free operation. The open drain WS/Clip\_L pin asserts when clipping occurs, and the Address0/Fault\_L pin asserts if any there are any other faults. In case of busfree operation the Address0/Fault is the logical OR of all fault conditions. When I<sup>2</sup>C bus is present, one can read detailed fault status, as well as control the diagnostics being performed via TDA7572's registers, Address0/Fault\_L is used to determine which one has to be the I<sup>2</sup>C bus Address0 of this IC or, in case of DAC operation, it is used to assert when clipping occurs. In this case the Address0 of I<sup>2</sup>C bus address is automatically set to zero, which implies that only two TDA7572 can be addressed. In any Mode case a clipping output is present.

The detailed procedure implemented to manage these faults follows:

### 10.1 Faults during operation:

#### 10.1.1 DC offset across the speaker

I<sup>2</sup>Cbus: If the module of VHOUTF1 - VHOUTF2 > 3Vfor more then 100ms the Offset bit in register Faults2 is set and the external FET's are tristated. The bit is cleared using the W1TC procedure. Resetting the bit removes the tristate mode and modulator operation is restored

No I<sup>2</sup>Cbus: Operation is as above except the fault is also reported by asserting the Address0/Fault\_L pin. In order to restart the system is necessary to pass through standby mode.

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#### 10.1.2 Die temperature

• I<sup>2</sup>Cbus: The Twarn bit in register Faults2 bus register is set when the first threshold is exceeded. If the second threshold is exceeded the SCR is enabled (only if the PassFETctrl bit is set to one) which allows the external power switch to latch off, and can only be restarted by removing and reapplying power. Twarn is cleared using the W1TC procedure.

• No I<sup>2</sup>Cbus: Operates as above, except the non-latched version (real-time version) of the Twarn bit is reported on the Address0/Fault\_L pin. The value of PassFETctrl is determined by the SDA/SCR Enb pin, which is read at powerup.

#### www.DataSheet4U10:11.3 External temperature

- I<sup>2</sup>C bus: The ExtTwarn bit is set if the voltage at the NTC pin exceeds the first threshold. If the second threshold is exceeded the SCR is enabled (only if the PassFETctrl register is set to one). ExtTwarn is cleared by the W1TC procedure
- No I<sup>2</sup>C bus: Operates as above, except the non-latched version (real-time version) of ExtTwarn register is reported on the Address0/Fault pin. The value of PassFETctrl bit is determined by the SDA/SCR\_Enb pin, which is read at powerup

#### 10.1.4 Output clipping

- I<sup>2</sup>C bus: The Clip bit in the Faults2 register is set when the clipping detected. The Clip bit is cleared by the W1TC procedure. Clipping is detected if there is maximum modulation or over current control at the modulator, or if the AOUT pin clips.
- No I<sup>2</sup>C bus: The instantaneous value of clipping, as defined above, is reported on the SCL/CLIP\_L pin. The pin is pulled low during a clipping event (assertion level low).
- DAC Enabled: To handle the case when the DAC is in use and to meet the requirement of a physical clipping signal, the clipping signal is brought out to the Addr0/Fault pin

#### 10.1.5 Output over-current

- I<sup>2</sup>C bus: The output current is clipped/limited by pulse injection into the modulator when the qualified VDS of the active FET exceeds the first threshold, at the same time the loutTrip bit is set. If the second threshold is exceeded the current is cycle-by-cycle limited by switching the FET's off after few microsecond. If the cycle-to-cycle limitation is present for more then 4 cycle the SCR is enabled (only if the PassFETctrl register is set to one) and the external FET are tristated. In case of the SCR is disabled the external FET are not tristated and the limitation still going. The register is cleared by the W1TC procedure.
- No I<sup>2</sup>Cbus: In addition to the above, the clipping out pin is engaged by the current limitation. The value of PassFETctrl bit is determined by the SDA/SCR\_Enb pin, which is read at powerup

Diagnostics TDA7572

#### 10.1.6 Power supply overcurrent

• I<sup>2</sup>Cbus: The bit IsenTrip is set when the voltage between the ISSENP and ISSENM pins exceeds the threshold. Also, the power control SCR is turned on (only if the PassFETctrl register is set to one). IsenTrip is cleared by the W1TC procedure.

- No I<sup>2</sup>Cbus: In addition the above, the non-latched version of IsenTrip register is reported on the Address0/Fault\_L pin. The value of PassFETctrl bit is determined by the SDA/SCR\_Enb pin, which is read at powerup:
- NOTE: The Output current is monitored only when the output signal is in the +/-1.2V (see offset detector specification) range for more then 100ms. When this condition is reached a switch present between ISSENM and ISSENP is switched off. Normally this switch shorts the ISSENM pin to the ISSENP, allowing external filter caps to used to condition the current sense signal.

10.1.7 Fault handling

#### Table 33. Fault handling

| Fault                    | 1 <sup>st</sup> Threshold (Bus mode: I <sup>2</sup> C/No I <sup>2</sup> C)                                    | 2 <sup>nd</sup> Threshold   |
|--------------------------|---|---|
| DC offset                | - Latch the offset bit<br>- Tristate the modulator  |   |
| DC onset                 | - Latch the offset bit and Fault pin - Tristate the modulator   |   |
|                          | - Latch the Twarn bit   |   |
| Die temperature          | - Latch the Twarn bit<br>- Assert the fault pin   | The SCR is activated if enabled   |
| Output clipping          | - Latch the Clip bit - Assert the SCL_CLIP_L (if no DAC) - Assert the Address0 (if DAC)                       |   |
|                          | - Latch the Clip bit<br>- Assert SCL_CLIP_L   |   |
|                          | - Latch the IsenTrip bit - Clip the output current by modulator injection                                     | Cycle-to-cycle Current limiting is activated.  If the cycle-by-cycle limitation is  |
| Output<br>overcurrent    | - Latch the IsenTrip bit - Clip the output current by modulator injection                                     | present for more then four PWM cycles the SCR is activated if the SCR is enabled and the output FET are tristated. If the SCR is disabled the cycle-by cycle limitation keep going. |
| Power supply overcurrent | - Latch the loutTrip bit<br>- The SCR is activated if enabled   |   |
|                          | <ul><li>Latch the loutTrip bit</li><li>Assert the Fault pin</li><li>The SCR is activated if enabled</li></ul> |   |

Note:

in legacy mode (no  $l^2C$  bus) the Output over-current warning information is not reported on the fault pin, while is present on the clipping detector output pin.

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TDA7572 Diagnostics

Events that put in tri-state the Modulator:

- Diagnostic on
- Offset detection
- Output over-current second threshold trespassed

Events that enable the Fault Pin without I<sup>2</sup>C bus:

- Diagnostic Fault
- Junction thermal warning
- External thermal warning
- Supply current over-threshold
- Offset detection

Events that enable the SCR:

- Over-temperature protection
- Output over-current second threshold trespassed
- Supply current over-threshold

#### 10.1.8 Faults during power-up:

This is a power-up diagnostic useful to detect: load short to ground, load short to supply, short across the transducer, open transducer. The PUD could be performed with and without I<sup>2</sup>C bus.

■ I<sup>2</sup>Cbus: setting the bit 4 of Fault1 register the diagnostic begin. The capacitor TestC is then charged by a Thevenin circuits with R = 155 kOhm and supply equal to 1.75V. The value of capacitor is choose in order to have an audible charge ramp and at the same time in order to have an acceptable charge time. The diagnostic time start when the TestC pin reaches the 98% of full charge. During the diagnostic time of 100 ms a current equal to

$$I = \frac{2.45}{3 \cdot RISet}$$

The drop across the load produced by this current is continuously monitored. A fault is detected if the drop and/or the absolute value of pin HB1Out and HB2Out are abnormal for the full 100 ms period set when a fault is detected the correspondent bit in the Fault1 register is set and the diagnostic keep running until the fault is present. In case no fault is detected after the 100 ms period the capacitor is discharged and the current on the load is reduced down to zero. When this current is at the 2% of is nominal value the bit 4 of Fault1 register is set to zero. Pulling this register the operator could understand the state of diagnostic. Note that during diagnostic cycle the output FET are in tristate.

No I<sup>2</sup>C bus: The operation of diagnostic is equal to the one with I<sup>2</sup>C bus. The only
differences are about the habilitation, which is selected by the mode, and the assertion
of fault presence, which is done trough the addr0/Fault pin. At the end of diagnostic the
Fault pin is for sure low and the external FET start to commute.

These are the thresholds to take into account for short to ground and short to supply

|                   | SG  | ND X |     | x   | Normal operation |      | x     |     | svcc |     |
|-------------------|-----|------|-----|-----|------------------|------|-------|-----|------|-----|
| Voltage threshold | VSM | VSM  | +1V | VSM | 1+2V             | VSM- | +5.5V | VSM | l+8V | VSP |

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Diagnostics TDA7572

These are instead the thresholds to take into account for the short and open transducers with some example with a predefined current

|                   | s | L Z   |    | X     | Normal load |    | х  |     | OL |   |
|-------------------|---|-------|----|-------|-------------|----|----|-----|----|---|
| Voltage threshold | - | 6 n   | nV | 20    | mV          | 1  | 1  | 2   | 2  | - |
| Itest=14mA        | - | 0.4Ω  |    | 1.43Ω |             | 71 | Ω  | 14  | 3Ω | - |
| Itest=140mA       | - | 0.04Ω |    | 0.14Ω |             | 7. | lΩ | 14. | 3Ω | - |

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TDA7572 Oscillator

#### 11 Oscillator

A common clock is needed to run all switching blocks at one frequency to avoid beating. The internally generated clock is used for the PWM modulators and to run the dc-dc converter. To blur the EMI spectrum, sub-audible frequency dither incorporated.

- When the DITH-sel pin is logic gnd then the internal oscillator operates without dither.
- With a cap there is +-100UA dithering functions
- Putting DITH-sel to VDIG allows an external clock to be accepted from CLKin-out at 4X the selected frequency
- Clock out is referred to VP2.5 and VM2.5, while external clock input is referred to DGND and VDIG
- External CLKin-out is always active. When DITH-sel is different to VDIG on this pin is present a 4X modulator frequency at digital level.

The dither acts to span the intermodulation products present around multiple of switching frequency. Dither the modulator frequency means make it slowly changing around a nominal value. In case of a capacitor is connected to the DITH-sel pin a triangular drop is present across it and the modulator frequency value follows these behave. The maximum value reaches by it is the nominal value plus 10%, while the minimum value is nominal one minus 10%. This pick frequency values are reached when the DITH-sel pin reach the maximum voltage value. The value of capacitor is involved in the ratio of variation of modulator frequency, provided that it acts on triangular wave frequency.

In case of DAC operation the modulator frequency of PWM digital out of this component is lock to the I2S input frequency, which is different from the analog modulator frequency imposed by the described oscillator. No high value intermodulation product are generated by difference of this frequency because the presence of filter between DAC out and Diff-to-SE input. However a multiple frequency of DAC could be imposed to analog modulator by the CLKin-out pin. In this case no dither can be introduced.

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### 12 Under voltage lock out (UVLO)

The UVLO lock at the voltage references value used to run the device. If some of them are not in the rate band the system is put in tristate or in stand-by. The Auto-mute Voltage Setting pin (pin56) voltage is used to define the limits of this voltage references.

List of monitored pin:

- 1. MODE0 and MODE1 voltage value
- VSP-VSM voltage difference
- 3. SVR voltage value
- 4. VSP-SVR or VSR-VSM voltage difference
- 5. V14 voltage value

In the UVLO could be defined four blocks:

- VSP UVLO
- VP2.5/VM2.5 UVLO
- V14 UVLO
- SVR UVLO

#### 12.1 VSP-UVLO

This block monitors the VSP-VSM drop and eventually moves the modulator in mute or in tristate. The limits imposed by the VSP-UVLO block are principally three:

- an adjustable limit on the minimum supply/drop
- 2. an adjustable limit on the maximum supply/drop
- 3. an absolute limit on the maximum supply

The adjustable limits are obtained by means of the reference voltage present on the AutomuteVSetting pin, which is fixed by means of a ladder resistor of R1 and R2 between VP2.5 and SVR.

The comparators that sense the voltage drop for the auto mute are provided of hysteresis. An hysteresis is still present for the auto-tristate and expressed in the spec as two different thresholds that are function of reference voltage and slope polarity.

#### 12.2 V14 - UVLO

This block monitors the V14-VSM drop voltage and eventually moves the modulator in mute or in tristate. The V14-UVLO block fixes a limit on the minimum drop.

An hysteresis is present for the auto-tristate and expressed in the spec as two different thresholds that are function of slope polarity. An hysteresis is still present for the auto-mute and expressed in the spec as two different thresholds that are function of auto-tristate threshold and slope polarity.

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#### 12.3 **SVR - UVLO**

This block monitors the SVR-VSM drop voltage and eventually moves the modulator in tristate. The SVR-UVLO block fixes a limit on the minimum drop.

An hysteresis is present for the auto-tristate and expressed in the spec as two different thresholds that are function of slope polarity. An hysteresis is still present for the auto-mute and expressed in the spec as two different thresholds that are function of auto-tristate threshold and slope polarity.

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# 13 Start-up procedures, modulator turn-on after a tristate condition.

#### 13.1 Start-up

Condition to be respected to turn-on the modulator at the start-up:

- Are MODE0 and/or MODE1 pins at voltage higher than 2.3V?
- Is the command "TristateMOD" Set to "1"?
- Is the PLL locked? (Only in case of digital Input)
- Is the Thermal protection FLAG ON?
- Are the VSP-VP2.5 and VM2.5-VSM drop voltage respectively over VAP and VAM?
- Is the VSP-VSM voltage lower than V<sub>U</sub> and V<sub>UC</sub>?
- Is the total VSP-VSM Higher than VPO+?
- Is the SVR pin higher than Vsvr+?
- Is the 14V pin supply higher than V14mute+?

TristateMOD represents an internal signal which is

- in NOI<sup>2</sup>CBUS MODE set to '1' when the digital supply pin VDIG (50) reaches its steady state value.
- in I<sup>2</sup>C MODE set to '1' when the digital supply pin VDIG (50) reaches its steady state value and by I<sup>2</sup>C bus is written '1' on the D4 bit of modulator register.
- in NOI<sup>2</sup>CDIAGNOSTIC set to '1' when the digital supply pin VDIG (50) reaches its steady state value and the turn-on diagnostic has positive result.

The thermal protection represent an internal signal which is set to '1' at the start-up and eventually set to '0' if

- the internal temperature trespass the second threshold and/or
- the external temperature trespass the second threshold

Once all the listed condition present in the above table are respected the modulator is get out from tri-state after  $\sim$ 500 $\mu$ s.

#### 13.2 Tristate

When the modulator is put in tristate by some diagnostic condition the system retrieve from this condition in two possible mode depending from the supplies configuration

- split supply: The modulator starts to switch ~500µs after all conditions listed in the above table are realized.
- Single-supply: Only in case of single supply, is activated a circuit that inhibit the startup of the SVR capacitor charge (then the modulator enable) if the SVR voltage is higher than 1.5V. If, during the normal activity of the modulator, an event that moves the modulator in tristate is present (due to, as example, an UVLO) the Vsvr gets to discharge until its value is under 1.5V. Ones reached this value the capacitor svr start to charge. The modulator starts to switch ~500µs after all conditions listed in the above table are realized. Purpose of this circuit is to avoid fast turn-off/on of the modulator and increase the pop performance.

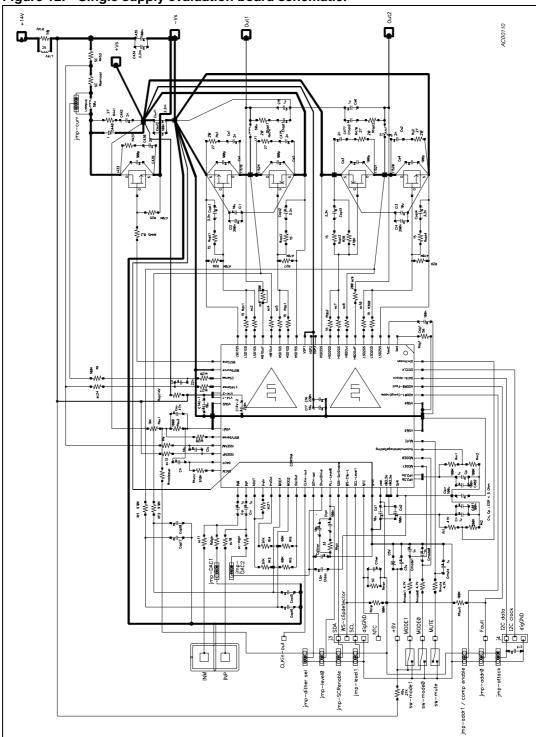
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TDA7572 Applications

# 14 Applications

### 14.1 Single supply

Figure 12. Single supply evaluation board schematic.

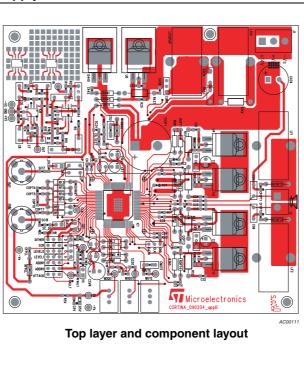


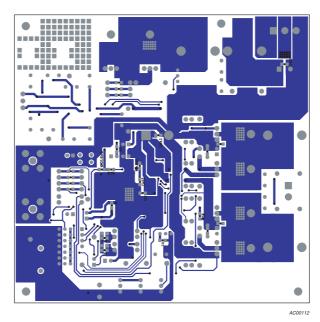
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Figure 13. Single supply evaluation PCB



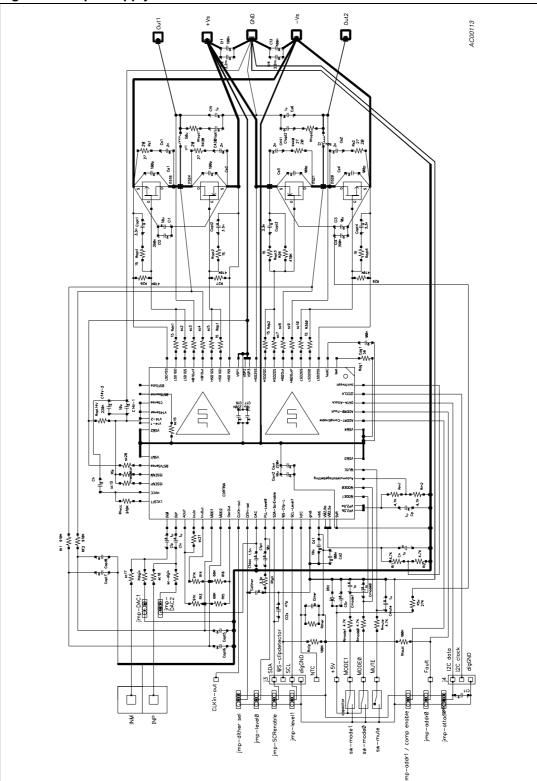


**Bottom layer** 

TDA7572 Applications

## 14.2 Split supply

Figure 14. Split supply evaluation board schematic.

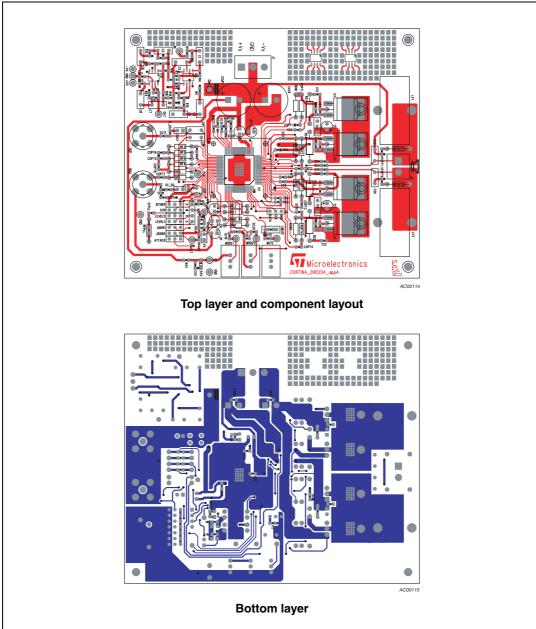


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Figure 15. Split supply evaluation PCB



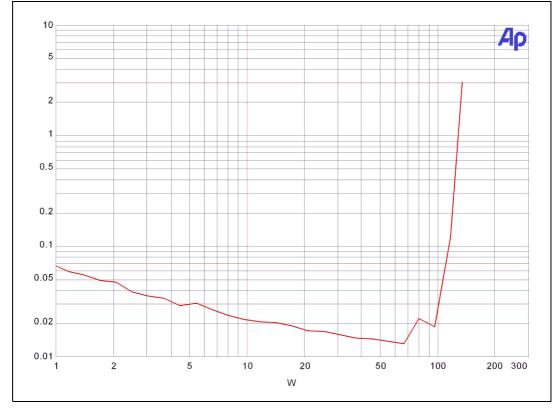
TDA7572 Applications

#### 14.3 THD+N step-up on

The graph below report the THD+N vs. Pout of a TDA7572 board with step-up on and 50Hz input sine wave. Condition and step to made the board working are:

- 1. connect a voltage supplier to the connector J1: Positive terminal (max 14V) connected to L14V, ground terminal connected to -Vs.
- 2. connect the differential input signal on INP and INM BNC input or connect the single ended input on the INP BNC and short cut the INM BNC.
- 3. connect the load of 40hm to the connector J2.
- 4. turn-on the device by means of MODE0 switch.
- 5. put in play the device by operating on MUTE switch

Figure 16. THD+N step-up on



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Package information TDA7572

### 15 Package information

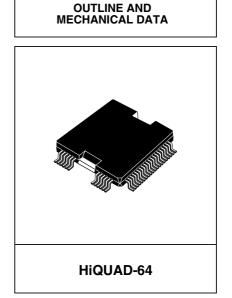
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark.

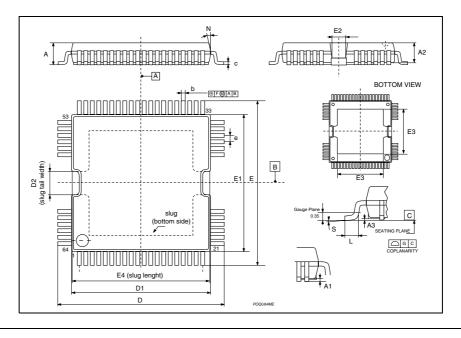
ECOPACK specifications are available at: www.st.com.

Figure 17. HiQUAD-64 mechanical data and package dimensions

| DIM.   |       | mm    |          |          | inch  |       |
|--------|-------|-------|----------|----------|-------|-------|
|        | MIN.  | TYP.  | MAX.     | MIN.     | TYP.  | MAX.  |
| Α      |       |       | 3.15     |          |       | 0.124 |
| A1     | 0     |       | 0.25     | 0        |       | 0.010 |
| A2     | 2.50  |       | 2.90     | 0.10     |       | 0.114 |
| A3     | 0     |       | 0.10     | 0        |       | 0.004 |
| b      | 0.22  |       | 0.38     | 0.008    |       | 0.015 |
| С      | 0.23  |       | 0.32     | 0.009    |       | 0.012 |
| D      | 17.00 |       | 17.40    | 0.669    |       | 0.685 |
| D1 (1) | 13.90 | 14.00 | 14.10    | 0.547    | 0.551 | 0.555 |
| D2     | 2.65  | 2.80  | 2.95     | 0.104    | 0.110 | 0.116 |
| Е      | 17.00 |       | 17.40    | 0.669    |       | 0.685 |
| E1 (1) | 13.90 | 14.00 | 14.10    | 0.547    | 0.551 | 0.555 |
| е      |       | 0.65  |          |          | 0.025 |       |
| E2     | 2.35  |       | 2.65     | 0.092    |       | 0.104 |
| E3     | 9.30  | 9.50  | 9.70     | 0.366    | 0.374 | 0.382 |
| E4     | 13.30 | 13.50 | 13.70    | 0.523    | 0.531 | 0.539 |
| F      |       | 0.10  |          |          | 0.004 |       |
| G      |       | 0.12  |          |          | 0.005 |       |
| ١      | 0.80  |       | 1.10     | 0.031    |       | 0.043 |
| N      |       |       | 10°(r    | nax.)    |       |       |
| S      |       | - (   | °(min.), | 7°(max.) |       |       |

<sup>(1): &</sup>quot;D1" and "E1" do not include mold flash or protusions
- Mold flash or protusions shall not exceed 0.15mm(0.006inch) per side





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TDA7572 Revision history

# 16 Revision history

Table 34. Document revision history

| Date       | Revision | Changes          |
|------------|----------|------------------|
| 3-Sep-2007 | 1        | Initial release. |

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